

Overview

Important Note: Features and Supported Configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W Processors and the Z4 G4 Workstation with Intel® Core™ X Processors. Where different - features are shown side by side. Supported configurations are indicated by the CPU Support references.

HP Z4 G4 Workstation



Front view

1. Front I/O module options
 - Premium (optional): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C™, Headset audio, SD Card Reader (optional) (Left-most Type-A port has charging capability)
 - Standard (shown here): power button, 4 USB 3.1 G1 Type-A (left-most Type-A port has charging capability), Headset audio, SD Card Reader (optional)
2. Front handle
3. 2 x 5.25" external drive bays

Overview



Internal view

Intel® Xeon® W Processors

4. Intel® Xeon® Processors: W-2100 family
5. 2 PCIe G3 x16, 2 PCIe G3 x4, 1 PCIe G3 x8
6. 2 PCIe G3 x4 M.2 for SSDs
7. 8 DIMM slots; DDR4-2666 ECC Registered RAM
8. PSU options:
 - 465W 90% efficient with 0 graphics power adapters
 - 750W 90% efficient with 2 graphics power adapters
 - 1000W 90% efficient with up to 4 graphics power Adapters

9. 2 x 5.25" external drive bays

10. 2 x 2.5"/3.5" internal drive bays

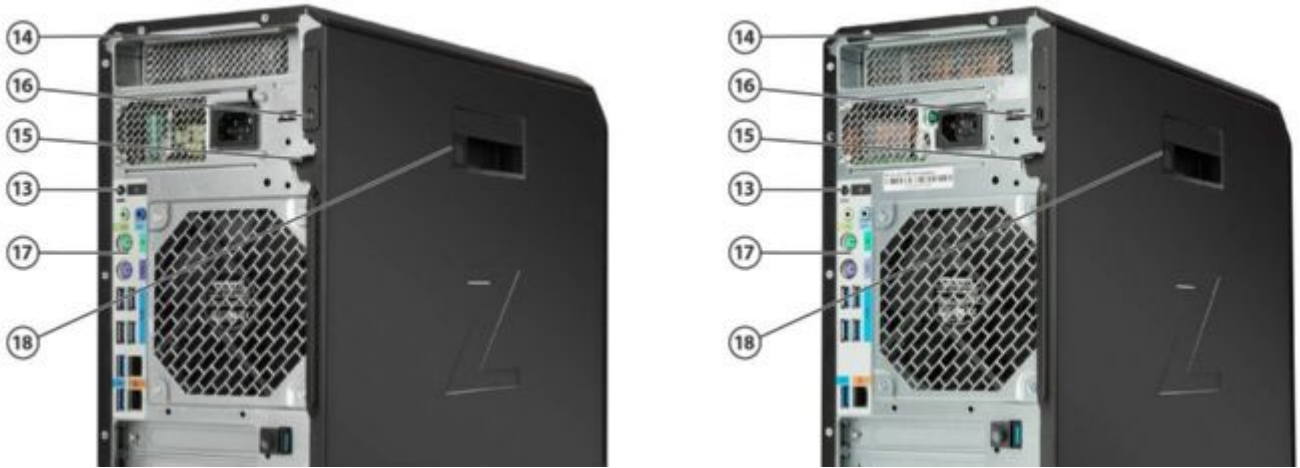
11. Front card guide and fan (select configurations)

12. 6 x 6Gb/s SATA ports

Intel® Core™ X-series Processors

4. Intel® Core™ i7-X-series processors
Intel® Core™ i9-X Series processors
Intel® Core™ i9 Extreme Edition processor
5. Core i9-X configs/Core i7 9800X: 2 PCIe G3 x16, 2 PCIe G3 x4, 1 PCIe G3 x8
Other Core i7-X configs: 1 PCIe G3 x16, 1 PCIe G3 x16 (x8 electrical), 2 PCIe G3 x4, 1 PCIe G3 x8 (mechanical only)
6. 1 PCIe G3 x4 M.2 for SSDs
7. 8 DIMM slots: DDR4-2666 Non-ECC Unbuffered RAM
8. PSU:
 - 1000W 90% efficient with up to 4 graphics power Adapters

Overview



Rear view

Intel® Xeon® W Processors

- 13. Rear I/O (top to bottom):
 - Audio in/out,
 - Keyboard/Mouse PS/2
 - USB: 6 USB 3.1 G1 Type-A
 - 2x 1GbE ports

Intel® Core™ X-series Processors

- Rear power button
- Rear handle
- Padlock loop
- Kensington lock slot
- 17. Rear I/O (top to bottom):
 - Audio in/out,
 - Keyboard/Mouse PS/2
 - USB: 5 USB 3.1 G1 Type-A
 - 1x 1GbE port

- 18. Side panel barrel keylock (optional)

Supported Components

Overview

Form Factor

Minitower

Operating Systems

Intel® Xeon® W Processors

Intel® Core™ X-series Processors

Preinstalled:

- Windows 10 Pro for Workstations*
- Ubuntu 20.04 LTS
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1-year support; no preinstalled OS)

Preinstalled:

- Windows 10 Pro*
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1-year support; no preinstalled OS)

Tested and Documented:

- Red Hat® Enterprise Linux® Workstation 6, 7, 8
- SUSE Linux® Enterprise Desktop 12, 15
- Ubuntu 16.04, 18.04, 20.04 LTS

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- Red Hat® Enterprise Linux® Workstation 6, 7, 8
- SUSE Linux® Enterprise Desktop 12, 15
- Ubuntu 16.04, 18.04, 20.04 LTS

Notes: For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

*Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for updates.

Note: In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows® 7 operating system on products configured with Intel® and AMD 7th Generation and forward processors or provide any Windows® 8 or Windows® 7 drivers on <http://www.support.hp.com>

Available Processors

| Name | Cores | Clock Speed (GHz) | Cache (MB) | Memory Speed (MT/s) | ECC memory support | Max memory support | Hyper-Threading | Featuring Intel® vPro™ Technology | Intel® Turbo Boost Technology 2.0 (GHz) ¹ | Intel® Turbo Boost Max Technology 3.0 (GHz) ² | TDP (W) |
|----------------------------------|-------|-------------------|------------|---------------------|--------------------|--------------------|-----------------|-----------------------------------|--|--|---------|
| Intel® Xeon® W Processors | | | | | | | | | | | |
| Intel® Xeon® W-2295 processor | 18 | 3.0 | 24.75 | 2933 | YES | 512GB | YES | YES | 3.8, 4.6 | 4.8 | 168 |
| Intel® Xeon® W-2275 processor | 14 | 3.3 | 19.25 | 2933 | YES | 512GB | YES | YES | 4.1, 4.6 | 4.8 | 165 |
| Intel® Xeon® W-2265 processor | 12 | 3.5 | 19.25 | 2933 | YES | 512GB | YES | YES | 4.3, 4.6 | 4.8 | 165 |
| Intel® Xeon® W-2255 processor | 10 | 3.7 | 19.25 | 2933 | YES | 512GB | YES | YES | 4.3, 4.5 | 4.7 | 165 |
| Intel® Xeon® W-2245 processor | 8 | 3.9 | 16.5 | 2933 | YES | 512GB | YES | YES | 4.5, 4.5 | 4.7 | 155 |
| Intel® Xeon® W-2235 processor | 6 | 3.8 | 8.25 | 2933 | YES | 512GB | YES | YES | 4.3, 4.6 | N/A | 130 |
| Intel® Xeon® W-2225 processor | 4 | 4.1 | 8.25 | 2933 | YES | 512GB | YES | YES | 4.5, 4.6 | N/A | 105 |

Supported Components

| | | | | | | | | | | | |
|--|----|-----|-------|------|-----|-------|-----|-----|----------|-----|-----|
| Intel® Xeon® W-2223 processor | 4 | 3.6 | 8.25 | 2666 | YES | 512GB | YES | YES | 3.7, 3.9 | N/A | 120 |
| Intel® Xeon® W-2145 processor | 8 | 3.7 | 11.00 | 2666 | YES | 512GB | YES | YES | 4.3, 4.5 | N/A | 140 |
| Intel® Xeon® W-2133 processor | 6 | 3.6 | 8.25 | 2666 | YES | 512GB | YES | YES | 3.8, 3.9 | N/A | 140 |
| Intel® Xeon® W-2125 processor | 4 | 4.0 | 8.25 | 2666 | YES | 512GB | YES | YES | 4.4, 4.5 | N/A | 120 |
| Intel® Xeon® W-2123 processor | 4 | 3.6 | 8.25 | 2666 | YES | 512GB | YES | YES | 3.7, 3.9 | N/A | 120 |
| Intel® Xeon® W-2104 processor | 4 | 3.2 | 8.25 | 2400 | YES | 512GB | NO | YES | N/A | N/A | 120 |
| Intel® Xeon® W-2102 processor | 4 | 2.9 | 8.25 | 2400 | YES | 512GB | NO | YES | N/A | N/A | 120 |
| Intel® Core™ X-Series Processors | | | | | | | | | | | |
| Intel® Core™ i9-10980XE Extreme Edition processor | 18 | 3.0 | 24.75 | 2933 | NO | 256GB | YES | NO | 3.8, 4.6 | 4.8 | 165 |
| Intel® Core™ i9-10940X X-series processor | 14 | 3.3 | 19.25 | 2933 | NO | 256GB | YES | NO | 4.1, 4.6 | 4.8 | 165 |
| Intel® Core™ i9-10920X X-series processor | 12 | 3.5 | 19.25 | 2933 | NO | 256GB | YES | NO | 4.3, 4.6 | 4.8 | 165 |
| Intel® Core™ i9-10900X X-series processor | 10 | 3.7 | 19.25 | 2933 | NO | 256GB | YES | NO | 4.3, 4.5 | 4.7 | 165 |
| Intel® Core™ i7-9800X processor | 8 | 3.8 | 16.5 | 2666 | NO | 128GB | YES | NO | 4.4 | 4.5 | 165 |
| <p>¹For Intel® Xeon® W processors, the specifications shown in this column represent the following: all core maximum turbo frequency, dual core maximum turbo frequency).</p> <p>For Intel® Core™ processors, the specifications shown in this column refer to dual core maximum turbo frequency.</p> <p>²Intel Turbo Boost Max Technology 3.0 identifies the best performing core(s) on a processor and provides increased performance on those cores by taking advantage of power and thermal headroom. Intel® Turbo Boost Max Technology 3.0 frequency is the clock frequency of the CPU when running in this mode.</p> <p>NOTE: Processors that do not have certain turbo functionality are denoted as N/A.</p> | | | | | | | | | | | |

Available Processors

Disclaimers

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Color

Black

Convertibility

No

Expansion Slots (see system board section for more details)

Intel® Xeon® W Processors

Intel® Core™ X-series Processors

Slot 0: Mechanical-only, for use with devices that require only rear bulkhead mounting

Slot 1: PCI Express Gen3 x16 (from CPU)

Slot 2: PCI Express Gen3 x4 (from PCH) with open-ended connector*

Supported Components

| | |
|---|--|
| <p>Slot 3: PCI Express Gen3 x16 (from CPU)</p> | <p>Slot 3: Core i9-X and Core i7-9800X configs: PCI Express Gen3 x16 (from CPU) Other Core i7-X configs: PCI Express Gen3 x16(mechanical) x8(electrical) (from CPU)</p> |
| <p>Slot 4: PCI Express Gen3 x4 (from PCH) with open-ended connector*</p> | |
| <p>Slot 5: PCI Express Gen3 x8 (from CPU) with open-ended connector*</p> | <p>Slot 5:</p> <ul style="list-style-type: none"> - Core i9-X and Core i7-9800X configs: PCI Express Gen3 x8 (from CPU) with open-ended connector* - Other Core i7-X configs: PCI Express Gen3 x8 (mechanical-only, no data) with open-ended connector* |
| <p>M.2 Slot 1: M.2 PCIe Gen 3 x4 (from CPU) up to 80mm storage devices</p> | |
| <p>M.2 Slot 2: M.2 PCIe Gen 3 x4 (from CPU) up to 80mm storage devices</p> | <p>M.2 Slot 2: No 2nd M.2 connector/slot available</p> |

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

Expansion Bays (see storage section for more details)

2 internal 3.5" bays (with acoustic dampening drive carriers pre-installed). Optional 2.5" adapter available.
2 external 5.25" bays

- 3rd and 4th 3.5" HDD each occupy one external bay
- 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier

Front I/O

- Base: Power button with power/fault LED, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging, provides 1.5A at 5V)
- Premium (optional): Power button with power/fault LED, Drive activity LED, 1 Headset audio port, 2 USB 3.1 G1 Type-A (1 charging, provides 1.5A at 5V), 2 USB 3.1 G2 Type-C™ (each provides 3A at 5V)
- Optional: SD reader

Internal I/O

1 USB 3.1 G1 single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port header

Rear I/O

| | |
|---|--|
| <p>Intel® Xeon® W Processor Family 6x USB 3.1 G1 Type-A* 2x 1GbE LAN ports (1x supporting Intel AMT)</p> | <p>Intel® Core™ X- Series Processor Family 5x USB 3.1 G1 Type-A 1x 1GbE LAN ports</p> |
|---|--|

Audio: 1 Line out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2 keyboard port, Rear power button
Optional: 1 serial port (cable up to rear bulkhead), 2 Thunderbolt 3**

*All rear I/O motherboard USB-A ports are 0.9A at 5V
**HP's add-in Thunderbolt card provides two USB-C ports which provide 3A at 5V each

Interfaces Supported

SD card reader (optional)
6-channel SATA interface (6 @ 6.0 Gb/s)
6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported)
Thunderbolt 3 (optional)
USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional)

On-board RAID Support

SATA RAID 0 Striped Array Configuration
SATA RAID 1 Mirrored Array Configuration
SATA RAID 5 Striped/Parity Configuration
SATA RAID 10 Striped/Mirrored Configuration

Chassis Dimensions (H x W x D)

H: 15.2" (386mm)
W: 6.65" (169mm)
D: 17.5" (445mm)

Supported Components

| | |
|---|--|
| Packaged Dimensions | H: 22.5" (572mm) W: 12.4" (314mm) D: 22.2" (563mm) |
| Palletization Profile | 6 units x 3 layers = 18 units per pallet 1200x1000x1836mm (pallet included) |
| Rack Dimensions | 4U |
| Weight | Exact weights depend upon configuration (System weight only). Minimum: 10.2 kg (22.4 lbs.) Standard: 11.3 kg (24.9 lbs.) Maximum: 17.3 kg (38.2 lbs.) |
| Temperature | Non-operating: -40° to 60° C (-40° to 140° F) Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Maximum rate of change: 10 °C/hr No direct sustained sunlight |
| Humidity | Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb |
| Maximum Altitude (non-pressurized) | Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details. |
| Power Supply | <p>Processor Support</p> <p>XW ENTRY 465 watts wide-ranging, active Power Factor Correction, 90% Efficient, with no 6-pin graphics power cables. The Z4 G4 465W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-465AB-3%20A_465W_ECOS%204939_Report.pdf</p> <p>XW MID_RANGE 750 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2x 6-pin graphics power cables. The Z4 G4 750W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-750AB-36%20A_750W_ECOS%204938_Report.pdf</p> <p>HIGH-END</p> <p>XW, CX (i9) 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient. Includes 4x 6+2-pin graphics power cables: also includes a Front Fan and Card Guide kit to enable support for dual high end graphics solutions.</p> <p>CX (i7) 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient. Includes 2x 6+2-pin graphics power cables.</p> <p>The Z4 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf</p> <p>NOTE: 1000 W internal power supply, up to 90% efficiency, active PFC available the first half of 2018</p> |
| Workstation ISV Certifications | See the latest list of certifications at http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html |

Supported Components

Processors

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| Intel® Xeon® W-Series CPU | | | | |
| Intel® Xeon® W-2295 3.0 2933 18C CPU | Y | | N | |
| Intel® Xeon® W-2275 3.3 2933 14C CPU | Y | | N | |
| Intel® Xeon® W-2265 3.5 2933 12C CPU | Y | | N | |
| Intel® Xeon® W-2255 3.7 2933 10C CPU | Y | | N | |
| Intel® Xeon® W-2245 3.9 2933 8C CPU | Y | | N | |
| Intel® Xeon® W-2235 3.8 2933 6C CPU | Y | | N | |
| Intel® Xeon® W-2225 4.1 2933 4C CPU | Y | | N | |
| Intel® Xeon® W-2223 3.6 2933 4C CPU | Y | | N | |
| Intel® Xeon® W-2145 3.7 2666 8C CPU | Y | | N | |
| Intel® Xeon® W-2133 3.6 2666 6C CPU | Y | | N | |
| Intel® Xeon® W-2125 4.0 2666 4C CPU | Y | | N | |
| Intel® Xeon® W-2123 3.6 2666 4C CPU | Y | | N | |
| Intel® Xeon® W-2104 3.2 2400 4C CPU | Y | | N | |
| Intel® Xeon® W-2102 2.9 2400 4C CPU | Y | | N | |
| Intel® Core™ X-Series CPU | | | | |
| Intel® Core™ i9-10980XE 3.0 2933 18C CPU | Y | | N | |
| Intel® Core™ i9-10940X 3.3 2933 14C CPU | Y | | N | |
| Intel® Core™ i9-10920X 3.5 2933 12C CPU | Y | | N | |
| Intel® Core™ i9-10900X 3.7 2933 10C CPU | Y | | N | |
| Intel® Core™ i7-9800X 3.8 2666 8C CPU | Y | | N | |

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Monitors / Displays

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--------------------------------|--------------------|--------------------|------------|------------------------|---------------|
| HP Z Display Z22n G2 | XW, CX | | Y | 1JS05AA | |
| HP Z Display Z23n G2 | XW, CX | | Y | 1JS06AA | |
| HP Z Display Z24i G2 | XW, CX | | Y | 1JS08AA | |
| HP Z Display Z24n G2 | XW, CX | | Y | 1JS09AA | |
| HP Z Display Z24nf G2 | XW, CX | | Y | 1JS07AA | |
| HP Z Display Z27n G2 | XW, CX | | Y | 1JS10AA | |
| HP Z Display Z27s (4K display) | XW, CX | | Y | J3G07AA | |

Supported Components

Supported by all operating systems available from HP
Screen size measured diagonally

Storage / Hard Drives*

SAS Hard Drives

| SAS Hard Drives for HP Workstations | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|-------------------------------------|--------------------|--------------------|------------|------------------------|---------------|
| HP 300GB 15k SAS SFF | XW | Y | Y | L5B74AA | |

NOTE: Only available on Xeon W configs SAS controller add-in card required

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity may be less. Up to 32GB (for Windows 10) is reserved for system recovery software.

SATA Hard Drives

| SATA (Serial ATA) Hard Drives for HP Workstations | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|--------------------|------------|------------------------|---------------|
| 500GB SATA 7200RPM 6Gb/s 3.5" HDD | XW, CX | Y | Y | LQ036AA | |
| 500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5" HDD | XW, CX | Y | Y | D8N29AA | |
| 1TB SATA 7200RPM 3.5" HDD | XW, CX | Y | Y | LQ037AA | |
| 1TB SATA 7200RPM Ent 3.5" HDD | XW, CX | Y | Y | W0R10AA | |
| 2TB SATA 7200RPM 3.5" CMR HDD | XW, CX | Y | Y | QB576AA | |
| 2TB SATA 7200RPM 3.5" SMR HDD | XW, CX | Y | Y | 8VE04AA/AT | |
| 2TB 7200RPM SATA 3.5in Enterprise | | Y | Y | 2Z274AA | |
| 4TB SATA 7200RPM Ent 3.5" HDD | XW, CX | Y | Y | K4T76AA | |
| 6TB SATA 7200RPM Ent 3.3" HDD | XW, CX | Y | Y | 3DH90AA | |
| 8TB 7200RPM SATA 3.5in Enterprise | | Y | Y | 2Z273AA | |

NOTES: Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0, 16TB max total

Supported Components

SATA Solid State Drives

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|--------------------|------------|------------------------|---------------|
| HP Solid State Drives (SSDs) for Workstations | | | | | |
| HP 256GB SATA SSD | XW, CX | Y | Y | A3D26AA/AT | |
| HP 512GB SATA SSD | XW, CX | Y | Y | D8F30AA | |
| HP 1TB SATA SSD | XW, CX | Y | Y | F3C96AA/AT | |
| HP 2TB SATA SSD | XW, CX | Y | Y | Y6P08AA/AT | |
| HP 256GB SATA SED OPAL2 SSD | XW, CX | Y | Y | G7U67AA | |
| HP 512GB SATA SED OPAL2 SSD | XW, CX | Y | Y | N8T26AA | |
| HP 240GB SATA Enterprise SSD | XW, CX | Y | Y | T3U07AA | |
| HP 480GB SATA Enterprise SSD | XW, CX | Y | Y | T3U08AA | |
| HP 960GB 2.5in Enterprise SATA-3 SSD | | Y | Y | 1W6P8AA | |
| 1920GB 2.5in Enterprise SATA-3 SSD | | Y | Y | 1W6P9AA | |

PCIe Solid State Drives

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|--------------------|------------|------------------------|---------------|
| PCIe SSDs for HP Workstations | | | | | |
| HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit | XW, CX | N | N | EOL | |
| HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit | XW, CX | N | N | EOL | |
| HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit | XW, CX | N | N | EOL | |
| HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit | XW, CX | Y | Y | 1PD59AA/AT | |
| HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit | XW, CX | Y | Y | 1PD60AA | |
| HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit | XW, CX | Y | Y | 1PD61AA | |
| HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit | XW, CX | Y | Y | 3KP39AA | |
| HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit | XW, CX | Y | Y | 4YZ41AA | |
| HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit | XW, CX | Y | Y | 4YZ44AA/AT | |
| HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit | XW, CX | Y | Y | 6YT76AA | |
| HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Module | XW, CX | Y | Y | 6YT79AA | 2 |
| HP Z Turbo 2TB SED OPAL2 TLC M.2 Z4/Z6 SSD | XW, CX | Y | Y | 2Y7W6AA | |
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | XW, CX | Y | Y | 8PE68AA | |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | XW, CX | Y | Y | 8PE69AA | |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | XW, CX | Y | Y | 8PE70AA | |
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Module | XW, CX | N | Y | 8PE62AA | 2 |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Module | XW, CX | N | Y | 8PE63AA | 2 |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Module | XW, CX | N | Y | 8PE64AA | 2 |
| HP 2TB PCIe NVMe TLC M.2 Z4/6 G4 SSD | XW, CX | Y | Y | 35F74AA | |
| HP Z Turbo Drive Quad Pro | | | | | |
| HP Z Turbo Drive Quad Pro 2x256GB TLC PCIe® SSD | XW, CX (i9) | Y | Y | 4YZ38AA | 1, 3 |
| HP Z Turbo Drive Quad Pro 2x512GB TLC PCIe® SSD | XW, CX (i9) | Y | Y | 4YZ39AA/AT | 1, 3 |
| HP Z Turbo Drive Quad Pro 2x1TB TLC PCIe® SSD | XW, CX (i9) | Y | Y | 4YZ40AA | 1, 3 |
| HP Z Turbo Drive Quad Pro 2x2TB PCIe® SSD | XW, CX (i9) | Y | Y | 3KP42AA | |

Supported Components

| | | | | | |
|--|-------------|---|---|------------|---------|
| HP Z Turbo Drive Quad Pro 256GB TLC SSD module | XW, CX (i9) | N | Y | 4YZ35AA | 1, 2, 3 |
| HP Z Turbo Drive Quad Pro 512GB TLC SSD module | XW, CX (i9) | N | Y | 4YZ36AA/AT | 1, 2, 3 |
| HP Z Turbo Drive Quad Pro 1TB TLC SSD module | XW, CX (i9) | N | Y | 4YZ37AA | 1, 2, 3 |
| HP Z Turbo Drive Quad Pro 2TB TLC SSD module | XW, CX (i9) | N | Y | 3KP43AA | 2 |
| HP Z Turbo Drive Dual Pro | | | | | |
| HP Z Turbo Drive Dual Pro 256GB TLC SSD | | Y | Y | 4YF60AA | |
| HP Z Turbo Drive Dual Pro 512GB TLC SSD | | Y | Y | 4YF61AA | |
| HP Z Turbo Drive Dual Pro 1TB TLC SSD | | Y | Y | 4YF62AA | |
| HP Z Turbo Drive Dual Pro 2TB TLC SSD | | Y | Y | 4YF63AA | |
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | XW, CX | Y | Y | 8PE74AA | |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | XW, CX | Y | Y | 8PE75AA | |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | XW, CX | Y | Y | 8PE76AA | |
| Intel® 905p Series SSD (Optane SSD) | | | | | |
| Intel® Optane SSD 905p 280GB AiC** | | Y | Y | 2SC47AA | |
| Intel® Optane SSD 905p 480GB AiC** | | Y | Y | 2SC48AA | |
| Intel® Optane SSD 905P 380GB M.2 PCIe Dual | | Y | Y | 6LA63AA | 1 |
| Intel® Optane SSD 905P 2x380GB M.2 PCIe Quad | | Y | Y | 6LA65AA | 1 |
| Intel® Optane SSD 905P 380GB M.2 SSD Module | | Y | Y | 6LA66AA | 2, 3 |

Note 1: All HP Z Turbo Drive Quad Pro modules require the Z4 G4 Fan & Front Card Kit, available as CTO (1MY89AV) and (1XM33AA)

Note 2: M.2 SSD module only, designed to be installed into the Z Turbo Drive Quad Pro or Dual Pro carrier

Note 3: Z Turbo Drive Quad Pro is not supported on Core i7-X configurations

** PCIe card installed in standard PCIe x4 slot

| Intel® Virtual RAID on CPU (Intel® VROC) for NVMe | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|--------------------|------------|------------------------|---------------|
| Intel® VROC NVMe SSD Standard Controller Module | | N | Y | 3FJ80AA | 1,3 |
| Intel® VROC NVMe SSD Premium Controller Module | | N | Y | 3FJ81AA | 2,3 |

NOTE 1: Enables RAID 0, 1 & 10

NOTE 2: Enables RAID 0, 1 & 10 plus RAID 5 with write hole closure options.

NOTE 3: Xeon processor required

Hard Drive Controllers

| SAS Controller | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|--------------------|------------|------------------------|---------------|
| MicroSemi SmartHBA2100-4i4e SAS Controller | XW | Y | Y | 1FV90AA | |

NOTE: Only available on Xeon W configurations

Graphics

Supported Components

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes | Supported # of cards |
|---|--------------------|--------------------|------------|------------------------|---------------|----------------------|
| Graphics Cable Adapters | | | | | | |
| HP DisplayPort to HDMI Adapter | XW, CX | Y | Y | K2K92AA | | |
| HP DisplayPort to Dual Link DVI Adapter | XW, CX | Y | Y | NR078AA | | |
| HP DisplayPort to DVI-D Adapter | XW, CX | Y | Y | FH973AA | | |
| HP DisplayPort to DVI-D Adapter (2-pack) | XW, CX | Y | N | | | |
| HP DisplayPort to DVI-D Adapter (4-pack) | XW, CX | Y | N | | | |
| HP DisplayPort to DVI-D Adapter (6-pack) | XW, CX | Y | N | | | |
| HP miniDP-to-DP Adapter | XW, CX | Y | Y | 2MY05AA | | |
| HP miniDP-to-DP Adapter (2-pack) | XW, CX | Y | N | | | |
| HP miniDP-to-DP Adapter (4-pack) | XW, CX | Y | N | | | |
| HP miniDP-to-DP Adapter (8-pack) | XW, CX | Y | N | | | |
| Graphics Card Connectors | | | | | | |
| NVIDIA® SLI 2-slot Graphics Connector | XW, CX | Y | Y | 2YY84AA | | |
| Quadro® RTX NVLink 2-slot Bridge (RTX 5000) | XW, CX | N | Y | 6FY12AA | | |
| Quadro® RTX NVLink High-Bandwidth 2-slot Bridge (RTX 6000 & 8000) | XW, CX | N | Y | 6FY11AA | | |
| NVIDIA NVLink 2-Slot Bridge | | N | Y | 340L2AA | | 2 |
| Entry 3D | | | | | | |
| NVIDIA® Quadro® P400 2GB Graphics | XW, CX | Y | Y | 1ME43AA | 4 | 2 |
| NVIDIA® Quadro® P620 2GB Graphics | XW, CX | Y | Y | 3ME25AA | 4 | 2 |
| NVIDIA® T400 2 GB GDDR6 LP Blower Fan 3mDP PCIe x16 Graphics | XW, CX | Y | Y | 340K8AA | 4 | 2 |
| NVIDIA® T600 4 GB GDDR6 Graphics | XW, CX | Y | Y | 340K9AA | 4 | 2 |
| Mid-range 3D | | | | | | |
| NVIDIA® Quadro® P1000 4GB Graphics | XW, CX | Y | Y | 1ME01AA | 3, 4 | 2 |
| NVIDIA® Quadro® P2000 5GB Graphics | XW, CX | N | Y | 1ME41AA | 3, 4 | 2 |
| NVIDIA® Quadro® P2200 5GB Graphics | XW, CX | Y | Y | 6YT67AA | 3, 4 | 2 |
| AMD Radeon™ Pro WX 3100 4GB Graphics | XW, CX | Y | Y | 2TF08AA | 3, 4 | 2 |
| AMD Radeon™ Pro WX 3200 4GB Graphics | XW, CX | Y | Y | 6YT68AA | 3, 4 | 2 |
| AMD Radeon™ Pro WX 4100 4GB Graphics | XW, CX | N | Y | Z0B15AA | 3, 4 | 2 |
| NVIDIA® T1000 4GB Graphics | XW, CX | Y | Y | 20X22AA | 3.4 | 2 |
| High-End 3D | | | | | | |
| NVIDIA® Quadro® P4000 8GB Graphics | XW, CX | Y | Y | 1ME40AA | 1, 2, 5 | 2 |
| NVIDIA® Quadro® RTX 4000 8GB Graphics | XW, CX | Y | Y | 5JV89AA | 1, 2 | 2 |
| NVIDIA® RTX A4000 16 GB 4DP Graphics | XW, CX | Y | Y | 20X24AA/AT | | 2 |
| AMD Radeon™ Pro W5500 8GB 4DP GFX | XW, CX | Y | Y | 9GC16AA | | 2 |
| AMD Radeon™ Pro W5700 8GB 5mDP+USBc GFX | XW, CX | Y | Y | 9GC15AA/AT | | 2 |
| AMD Radeon™ Pro WX 7100 8GB Graphics | XW, CX | Y | Y | Z0B14AA | 1, 2 | 2 |
| Ultra High-End 3D | | | | | | |
| NVIDIA® Quadro® GP100 16GB Graphics | XW, CX | N | | 1ZE81AA | 1, 2, 5 | 2 |
| NVIDIA® Quadro® GV100 32GB Graphics | XW, CX | Y | | 3ME26AA | 1, 2, 5 | 2 |
| NVIDIA® Quadro® P5000 16GB Graphics | XW, CX | Y | Y | Z0B13AA | 1, 2, 5 | 2 |

Supported Components

| | | | | | | |
|---|--------|---|---|---------|---------|---|
| NVIDIA® Quadro® P6000 24GB Graphics | XW, CX | Y | Y | Z0B12AA | 1, 2, 5 | 2 |
| NVIDIA® Quadro® RTX 5000 16GB Graphics | XW, CX | Y | Y | 5JH81AA | 1, 2 | 2 |
| NVIDIA® Quadro® RTX 6000 24GB Graphics | XW, CX | Y | Y | 5JH80AA | 1, 2 | 2 |
| NVIDIA® Quadro® RTX 8000 48 GB Graphics | XW, CX | Y | Y | 6NB51AA | 1, 2 | 2 |
| NVIDIA® RTX A5000 24 GB Graphics | XW, CX | Y | Y | 20X23AA | 1,2, 5 | 2 |
| NVIDIA® RTX A6000 48GB Graphics | XW, CW | Y | Y | 2S6U3AA | 1,2, 5 | 2 |
| AMD Radeon™ Pro WX 9100 16GB Graphics | XW, CX | Y | | 2TF01AA | 1, 2 | 1 |
| NVIDIA® Quadro® Sync II | XW, CX | N | Y | 1WT20AA | | |

NOTE 1: Single graphics configuration requires the HP Z4 G4 Fan and Front Card Guide Kit, which is available both CTO (1MY89AV) and AMO (1XM33AA).

NOTE 2: Single graphics configuration requires the 750W chassis or 1000W chassis.

NOTE 3: Dual graphics configuration requires the HP Z4 G4 Fan and Front Card Guide Kit, which is available both CTO (1MY89AV) and AMO (1XM33AA).

NOTE 4: Dual graphics configuration requires the 750W chassis or 1000W chassis.

NOTE 5: Dual graphics configuration requires the 1000W chassis.

Memory

| | SL Processor | CL Processor | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---------------------------------------|--------------|--------------|--------------------|--------------------|------------|------------------------|---------------|
| HP 8GB (1x8GB) DDR4-2666 ECC Reg RAM | Y | N | XW | Y | Y | 1XD84AA/AT | 1 |
| 16GB (1x16GB) DDR4-2666 ECC Reg RAM | Y | N | XW | Y | Y | 1XD85AA/AT | 1 |
| 32GB (1x32GB) DDR4-2666 ECC Reg RAM | Y | N | XW | Y | Y | 1XD86AA/AT | 1,2 |
| HP 8GB (1x8GB) DDR4- 2933 ECC Reg RAM | Y | Y | XW | Y | Y | 5YZ56AA /AT | 1,3 |
| 16GB (1x16GB) DDR4- 2933 ECC Reg RAM | N | Y | XW | Y | Y | 5YZ54AA/AT | 1,3 |
| 32GB (1x32GB) DDR4- 2933 ECC Reg RAM | N | Y | XW | Y | Y | 5YZ55AA / AT | 1,2,3 |
| 64GB (1x64GB) DDR4- 2933 ECC Reg RAM | N | Y | XW | Y | Y | 5YZ57AA / AT | 1,3,4 |
| HP 8GB (1x8GB) DDR4-2933 nECC RAM | Y | Y | CX | Y | Y | 7ZZ64AA /AT | 1,3,5 |
| HP 16GB (1x16GB) DDR4-2933 nECC RAM | N | Y | CX | Y | Y | 7ZZ65AA / AT | 1,3,5 |
| HP 32GB (1x32GB) DDR4-2933 nECC RAM | N | Y | CX | Y | Y | 7ZZ66AA/AT | 1,3,4 |

SL Processor: Are processors formerly known as Intel® Skylake that are sold under the model name Intel® Xeon® W-2100 Family, Intel® Core™ i7X, Core™ i9-7900X/XE, and Core™ i9-9000X/XE family

CL Processor: Are processors formerly known as Cascade Lake that are in model name Intel® Xeon® W-2200 family or Intel® Core™ i9-10900X/XE family

NOTES1: ONLY DDR4 DIMMs are supported.

2: Memory configurations using Xeon Skylake (W-21xx) processors and 32GB Registered DIMMs require the HP Z4 Memory Cooling Solution, which is available both CTO (1MY90AV) and AMO (8TC68AA).

3: Intel® Core™ i9-10900X/XE and Intel® Xeon® W-2200 family processors only support 2933 speed memory.

4:

- 32GB nECC Memory is only available with Intel® Core™ i9-10900X/XE family processors.
- 64GB Registered Memory is only available with Intel® Xeon® W-2200 family processors.

5: Discontinued Core i7X, Core i9-7900X/XE, and Core i9-9000X/XE family processors are only compatible with Memory Option 7ZZ64AA/AT 8GB (1x8GB) DDR4 2933 NECC UDIMM Memory

Supported Components

Option Kit 7ZZ65AA/AT 16GB (1x16GB) DDR4 2933 NECC UDIMM Memory has transitioned to newer 16Gbit DRAM and is incompatible with these discontinued Core X processors.

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxxAT) HP memory part numbers designated as "2666" may ship with "2933" or "3200" speed memory components. Similarly, HP Memory part numbers designated as "2933" may ship with "3200" speed memory. This does not affect HP part number availability, nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" or 2933 have been fully qualified to work with fast speed memory and are fully supported by HP under standard support terms.

| Factory Configured System Memory Solutions | Available with Intel Xeon Processor & Registered Memory | Available with Intel Core X Processor & nECC Memory |
|--|---|---|
| 8GB (1x8GB) DDR4 | Yes | Yes |
| 16GB (1x16GB) DDR4 | Yes | Yes |
| 16GB (2x8GB) DDR4 | Yes | Yes |
| 24GB (3x8GB) DDR4 | Yes | Yes |
| 32GB (2x16GB) DDR4 | Yes | Yes |
| 32GB (4x8GB) DDR4 | Yes | Yes |
| 64GB (2x32GB) DDR4 | Yes | Yes (Note 1) |
| 64GB (4x16GB) DDR4 | Yes | Yes |
| 64GB (8x8GB) DDR4 | Yes | Yes |
| 128GB (2x64GB) DDR4 | Yes (Note 2) | No |
| 128GB (4x32GB) DDR4 | Yes | Yes (Note 1) |
| 128GB (8x16GB) DDR4 | Yes | Yes |
| 192GB (6x32GB) DDR4 | Yes | Yes (Note 1) |
| 256GB (4x64GB) DDR4 | Yes (Note 2) | No |
| 256GB (8x32GB) DDR4 | Yes | Yes (Note 1) |
| 384GB (6x64GB) DDR4 | Yes (Note 2) | No |
| 512GB (8x64GB) DDR4 | Yes (Note 2) | No |

NOTE 1: 32GB nECC Memory Configurations are only available with Intel® Core™ i9-10900X/XE family processors.

NOTE 2: 64GB Registered Memory Configurations are only available with Intel® Xeon® W-2200 family processors.

Multimedia and Audio Devices

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------------------|--------------------|--------------------|------------|------------------------|---------------|
| Integrated Realtek HD ALC221 Audio | XW, CX | Y | N | | |

Optical and Removable Storage

Supported Components

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|--------------------|------------|------------------------|---------------|
| HP SlimTray Optical Drives | | | | | |
| HP 9.5mm Slim Blu Ray Disc Writer | XW, CX | Y | Y | K3R65AA | 1 |
| HP 9.5mm Slim DVD ROM | XW, CX | Y | Y | K3R63AA | 1 |
| HP 9.5mm Slim DVD Writer* | XW, CX | Y | Y | K3R64AA | 1 |
| HP HH DVD Writer (16x RW DVD-R) | XW, CX | Y | Y | 4AR67AA | |
| HP SD Card Reader | | | | | |
| HP SD 4 Card Reader | XW, CX | Y | Y | 2VK54AA | |
| NVMe Frame/Carrier | | | | | |
| HP QX310 Removable NVMe Frame/Carrier w/PCIe card | XW, CX | Y | N | | |
| HP QX310 Removable Carrier only | XW, CX | N | Y | 8GQ91AA/AT | 2 |

NOTE 1: Installing an optical drive into Z4 G4 requires a 5.25" external bay adapter (Option Kit Part number NQ099A).

NOTE 2: Only approved HP Z Turbo storage devices are supported.

*Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. Some movies cannot be played on this workstation.

Networking and Communications

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|--------------------|------------|------------------------|---------------|
| Intel® i350-T2 PCIe Dual Port Gigabit NIC | XW, CX | Y | Y | V4A91AA | |
| Intel® i350-T4 PCIe 4-Port Gigabit NIC | XW, CX | N | Y | W8X25AA | |
| Intel® Ethernet I210-T1 PCIe x1 Gb NIC | XW, CX | Y | Y | E0X95AA | |
| Aquantia® AQN-108 Single-Port 5GbE NIC | XW, CX | N | Y | 1PM63AA | |
| Intel® X550-T2 10GbE Dual Port NIC | XW, CX | Y | Y | 1QL46AA | |
| Intel® X710-DA2 10GbE SFP+ Dual Port NIC | XW, CX | Y | Y | 1QL47AA | 1 |
| HP 10GbE SFP+ SR Transceiver | XW, CX | Y | Y | C3N53AA | |
| Intel 8265 802.11 a/b/g/n/ac + BT PCIe WLAN | XW, CX | N | Y | 1QL48AA | |
| Intel® Wi-Fi 6 AX200 & BT PCIe | XW, CX | N | Y | 7CE01AA | |
| Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC | | Y | Y | 1C7Q2AA | |

Note 1: Windows 7 is NOT supported

Racking and Physical Security

Supported Components

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|--------------------|------------|------------------------|---------------|
| HP Z4/Z6 Side Panel Barrel Keylock | XW, CX | Y | N | | |
| HP Solenoid Lock / Hood Sensor | XW, CX | Y | N | | |
| HP Z4/Z6 G4 Depth Adjustable Fixed Rail Rack Kit | XW, CX | N | Y | 2HW42AA | |
| HP Z2 Mini/Z2 TWR/Z4/Z6 Depth Adj Rail Rak Kit | | | Y | 2A8Y5AA | |
| HP Keyed Cable Lock 10mm | XW, CX | N | Y | T1A62AA | |
| HP Master Keyed Cable Lock 10mm | XW, CX | N | Y | T1A63AA | |

Input Devices

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|--------------------|------------|------------------------|---------------|
| HP Wireless Business Slim Keyboard and Mouse | XW, CX | Y | Y | N3R88AA | |
| Business Slim PS/2 Wired Keyboard | XW, CX | Y | Y | N3R86AA | |
| USB Business Slim Wired Keyboard | XW, CX | Y | Y | N3R87AA | |
| USB Premium Wired Keyboard | XW, CX | Y | Y | Z9N40AA/AT | |
| USB Wired SmartCard CCID Keyboard | XW, CX | Y | Y | E6D77AA | |
| 3Dconnexion CADMouse | XW, CX | Y | Y | M5C35AA | |
| 3DConnexion 3 Button Wired CAD Mouse Pro | XW, CX | N | Y | 2H5H5AA | |
| HP Optical USB Mouse | XW, CX | Y | Y | QY777AA/AT | |
| HP PS/2 Mouse | XW, CX | Y | Y | QY775AA/AT | |
| HP USB Hardened Mouse | XW, CX | Y | Y | P1N77AA/AT | |

Other Hardware

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|--------------------|------------|------------------------|---------------|
| HP ENERGY STAR® Certified Configuration | XW, CX | Y | | | |
| HP Z Premium Front I/O 2xUSB-A 2xUSB-C | XW, CX | Y | Y | 1XM32AA | |
| HP Thunderbolt 3 PCIe 2 Port I/O Card | XW, CX | Y | Y | 3UU05AA | |
| HP Z4 G4 Memory Cooling Solution | XW, CX | Y | Y | 8TC68AA | Note 1 |
| HP Z4 G4 Fan and Front Card Guide Kit | XW, CX | Y | Y | 1XM33AA | Note 2 |
| HP Internal USB Port Kit | XW, CX | N | Y | EM165AA | Note 3 |
| HP eSATA 2 port PCIe Bulkhead Kit | XW, CX | Y | Y | GM110AA | |
| HP Serial Port Adapter | XW, CX | Y | Y | PA716A | |
| HP Workstation Mouse Pad | XW, CX | Y | | | |

Note 1: The HP Z4 G4 Memory Cooling Solution is available to add to any configuration for improved system cooling. It is required for memory configurations using Xeon Processors and 32GB Registered DIMMs.

Note 2: Fan and Front Card Guide required with the following components:
- Specific graphics configurations (see Graphics section above)

Supported Components

- Any HP Z Turbo Quad Pro configuration

Note 3: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Software

| | Processor Supports | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------|--------------------|--------------------|------------|------------------------|---------------|
| Sobey Video Editing SW | XW, CX | Y | N | | China only |
| ZCentral Remote Boost | XW, CX | Y | N | | |
| HP Sure Start Gen3 | XW, CX | Y | N | | 1 |

Note 1: Available on products equipped with Intel® 7th generation processors.

Operating Systems

| | Processor Supports | Support Notes |
|---|--------------------|---------------|
| Windows 10 Pro for Workstations | XW | Note 1 |
| Windows 10 Pro | CX | |
| Windows 7 Professional 64-bit | XW | Note 3 |
| Ubuntu 20.04 LTS | XW | |
| HP Linux® Ready | XW, CX | Note 4 |
| Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr) | XW, CX | Note 5 |

*only available in China through June 2019.

NOTE 1: Only applicable to Xeon W configurations

NOTE 2: Not supported for Core X configurations. For detailed Windows 7 OS hardware support information see <http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf>.

NOTE 3: For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

NOTE 4: This second OS must be ordered with the HP Linux® Installer Kit as the first OS.

System Technical Specifications

System Board

System Board Form Factor

Main System Board:
27.7 x 28.0 cm
10.9 x 11.0 inches
Single LGA2066 R4

Processor Socket

Chipset

Intel® Xeon® W Processor Family
Intel® C422 Chipset

Intel® Core™ X-series Processors
Intel® X299 chipset

Super I/O Controller

Nuvoton NPCD315HA0DX (SIO-15)

Memory Expansion Slots

8 DDR4 memory slots

Memory Type Supported

DDR4, RDIMM (Registered), ECC

DDR4, UDIMM, non-ECC

Memory Modes

Channel Interleaved

Memory Speed Supported

2933MT/s, 2666MT/s, 2400MT/s, and 2133MT/s

Memory Protection

ECC available on data, parity on address and command

N/A

Maximum Memory

Supports up to 512GB

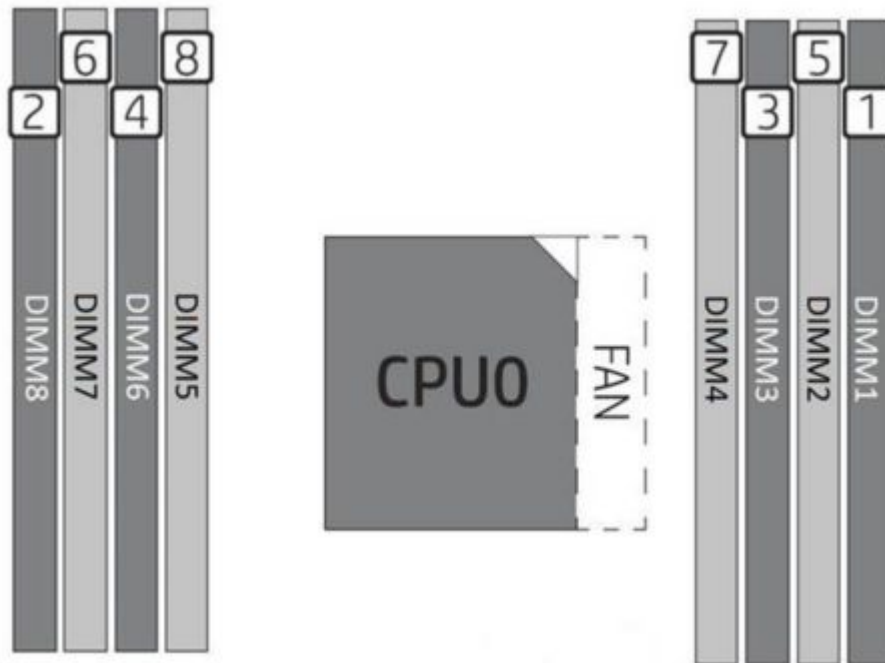
Supports up to 256GB

Memory Configuration (Supported)

Only Registered DIMMs are supported.

Only non-ECC unbuffered DIMMs are supported

Memory Load Order



Note on Maximum Memory Maximum memory capacities assume 64-bit operating systems such as Windows 10 Pro, Windows 7 Professional, or Windows 7 Ultimate. For 32-bit operating systems, the maximum accessible system memory is 4GB.

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible system memory is 192GB.

PCI Express Connectors

Intel® Xeon® W Processor Family

Intel® Core™ X-series Processors

Slot 1 (top): PCI Express Gen3 x16 supplied by CPU.

Slot 2 (PCH): PCI Express Gen3 x4 supplied by PCH with open-ended connector. **

System Technical Specifications

| | |
|---|---|
| <p>Slot 3: PCI Express Gen3 x16 supplied by CPU</p> | <p>Slot 3: Core i9-X and Core i7-9800X configs: PCI Express Gen3 x16 supplied by CPU Core i7-X configs: PCI Express Gen3 x16 (mechanical)/x8 (electrical) supplied by CPU</p> |
| <p>Slot 4 (PCH): PCI Express Gen3 x4 supplied by PCH with open-ended connector**</p> | |
| <p>Slot 5: PCI Express Gen3 x8 supplied by CPU with open-ended connector**</p> | <p>Slot 5: - Core i9-X and Core i7-9800X configs: PCI Express Gen3 x8 supplied by CPU with open-ended connector** - Other Core i7-X configs: PCI Express Gen3 x8 (mechanical-only, no data) with open-ended connector**</p> |
| <p>NOTE: Slots 1 through 5 support full-height, full-length cards (with extender)</p> | |
| <p>M.2 Slot 1: PCI Express Gen3 x4 supplied by CPU Socket Type 3, Key M, H4.2, sizes 2260-D5-M, 2280-D5-M, 22110-D5-M</p> | |
| <p>M.2 Slot 2: PCI Express Gen3 x4 supplied by CPU Socket Type 3, Key M, H4.2, sizes 2260-D5-M, 2280-D5-M, 22110-D5-M</p> | <p>M.2 Slot 2: No 2nd M.2 connector/slot available</p> |
| <p>** Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.</p> | |

Supported Drive Interfaces

| | |
|-------------|--|
| SATA | 6 SATA @ 6GB/s, supports RAID 0, 1, 5, and 10 Factory integrated Intel® SATA RAID is Microsoft Windows only |
|-------------|--|

| | | |
|-----------------------------|---|--|
| Serial Attached SCSI | Intel® Xeon® W Processor Family Requires Optional PCIe card | Intel® Core™ X-series Processors not supported |
|-----------------------------|---|--|

| | |
|--------------------------------|---|
| Factory Configured RAID | <ul style="list-style-type: none"> • RAID 0 striped array • RAID 1 mirrored array • RAID 10 striped and mirrored array <p>*HW RAID functionality not supported by Linux®. Use SW RAID functionality provided in the Red Hat® Operating system instead.</p> |
|--------------------------------|---|

| | |
|----------------------------|----|
| Integrated Graphics | No |
|----------------------------|----|

| | | |
|---------------------------|--|---|
| Network Controller | Intel® Xeon® W Processor Family Intel® I219-LM PCIe GbE LAN Intel® I210-AT PCIe GbE LAN Supports the following management functionalities: Intel AMT11.1x, TXT, DASH 1.1, WOL, VLAN, Teaming and PXE 2.1 | Intel® Core™ X-series Processors Intel® I219-V PCIe GbE LAN Supports the following management functionalities: WOL and PXE 2.1 |
|---------------------------|--|---|

| | |
|------------------------------|---|
| External SATA (eSATA) | Supported on all SATA ports configurable with optional eSATA* cable kit * hot plug / hot swap not supported with eSATA |
|------------------------------|---|

| | |
|----------------------|----|
| IDE connector | No |
|----------------------|----|

| | |
|-------------------------|----|
| Floppy connector | No |
|-------------------------|----|

| | |
|---------------|-------------------|
| Serial | 1 internal header |
|---------------|-------------------|

| | |
|-------------------|----|
| 2nd Serial | No |
|-------------------|----|

| | |
|-----------------|----|
| Parallel | No |
|-----------------|----|

| | |
|-----------------------|----|
| AUX IN (audio) | No |
|-----------------------|----|

System Technical Specifications

IEEE 1394 Connector(s)

| | |
|----------|------|
| Front | None |
| Rear | None |
| Internal | None |

USB Connector(s)

| | |
|-------|---|
| Front | Front USB depends on which FIO module is selected: |
| | - Standard: 4 USB 3.1 G1 Type A (1 charging) |
| | - Premium: 2 USB 3.1 G2 Type C™, 2 USB 3.1 G1 Type A (1 charging) |

| | | |
|-------------|--|---|
| Rear | Intel® Xeon® W Processor Family | Intel® Core™ X-series Processors |
| | 6 USB 3.1 G1 Type A | 5 USB 3.1 G1 Type-A |

| | |
|-----------------|--|
| Internal | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
|-----------------|--|

HD Integrated Audio Realtek ALC221

Flash ROM Yes

CPU Fan Header Yes

Rear Chassis Fan Header Yes

Front PCI Fan Header Yes

Front Control Panel/Speaker Header Yes

CMOS Battery Holder - Lithium Yes

Integrated Trusted Platform Module Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)
Common Criteria EAL4+ Certified
Convertible to FIPS 140-2 Certified mode through firmware v7.80
TPM Certified products list:
<https://trustedcomputinggroup.org/membership/certification/tpm-certified-products/>

Power Supply Headers Yes

Power Switch, Power LED & Hard Drive LED Header Yes

Clear Password Jumper Yes

Serial Port 1 internal header

Parallel Port No

Keyboard/Mouse USB or PS/2

Hood Lock Header Yes

Hood Sensor Header Yes

Memory Fan 1 Memory Fan Header

AUX IN (audio) No

Power Supply

| | |
|--------------------------------|--------------------------------|
| 750W 90% Efficient, Custom PSU | 465W 90% Efficient, Custom PSU |
|--------------------------------|--------------------------------|

Power Supply

| | |
|----------------------------|----------------------------|
| (Wide-Ranging, Active PFC) | (Wide-Ranging, Active PFC) |
| 90-269 VAC | 90-269 VAC |

Operating Voltage Range

| | | | |
|-------------|---------|-------------|---------|
| 100-240 VAC | 118 VAC | 100-240 VAC | 118 VAC |
|-------------|---------|-------------|---------|

Rated Voltage Range

| | | | |
|----------|--------|----------|--------|
| 50-60 Hz | 400 Hz | 50-60 Hz | 400 Hz |
|----------|--------|----------|--------|

Rated Line Frequency

| | | | |
|----------|------------|----------|------------|
| 47-66 Hz | 393-407 Hz | 47-66 Hz | 393-407 Hz |
|----------|------------|----------|------------|

Operating Line Frequency Range

System Technical Specifications

| | | | | |
|--|---|------------|---|-----------|
| Rated Input Current | 100-240V @ 10A | 118V @ 10A | 100-240V @ 6A | 118V @ 6A |
| Heat Dissipation (Configuration and software dependent) | Typical = 1850 btu/hr Max = 3084 btu/hr | | Typical = 1147 btu/hr Max = 1912 btu/hr | |
| Power Supply Fan | 80x25 mm variable speed | | 80x25 mm variable speed | |
| ENERGY STAR® Certified (Configuration dependent) | Yes | | Yes | |
| | 90% Efficient | | 90% Efficient | |
| 80 PLUS® Compliant | The Z4 G4 750W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-750AB-36%20A_750W_ECOS%204938_Report.pdf | | The Z4 G4 465W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-465AB-3%20A_465W_ECOS%204939_Report.pdf | |
| Power Supply | 1000W 90% Efficient, Custom PSU (Wide-Ranging, Active PFC) | | | |
| Operating Voltage Range | 100-127 VAC | | 90-269 VAC | |
| Rated Voltage Range | 200-240 VAC | | 118 VAC | |
| Rated Line Frequency | 50-60 Hz | | 400 Hz | |
| Operating Line Frequency Range | 47-66 Hz | | 393-407 Hz | |
| Rated Input Current | 12A @100-127 VAC | | 12A @ 118VAC | |
| | 6.3A @ 200-240 VAC | | | |
| Heat Dissipation (Configuration and software dependent) | Typical = 2467 btu/hr Max = 4112 btu/hr | | | |
| Power Supply Fan | 80x25 mm variable speed | | | |
| ENERGY STAR® Certified (Configuration dependent) | Yes | | | |
| | 90% Efficient | | | |
| 80 PLUS® Compliant | The Z4 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf | | | |
| FEMP Standby Power Compliant @115V <1W in S5 - Power Off) | Yes | | Yes | |
| EuP Compliant @ 230V (<0.5 W in S5 - Power Off) | Yes | | Yes | |
| CECP Compliant @ 220V (<4W in S3 - Suspend to RAM) | Yes; Configuration dependent | | Yes; Configuration dependent | |
| Power Consumption in sleep mode (as defined by ENERGY STAR®) - Suspend to RAM (S3) (Instantly Available PC) | TBD | | TBD | |
| Built-in Self Test LED | Yes | | Yes | |
| Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V) | Yes | | Yes | |

System Technical Specifications

NOTE: 1000 W internal power supply, up to 90% efficiency, active PFC available the first half of 2018

System Configuration

| | | | | | | | |
|---|-----------------------|---|--------------|-------------|--------------|--------------|--------------|
| Example Z4 G4 Workstation Configuration #1 ENERGY STAR® Certified | Processor | 1x Intel Xeon W-2102 4C 2.9GHz | | | | | |
| | Memory | 1x 8GB DDR4-2666 (Registered DIMM) | | | | | |
| | Graphics | 1x NVIDIA Quadro P400 | | | | | |
| | Disks / Optical | 1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA | | | | | |
| | Power Supply | 465W 90% custom PSU | | | | | |
| | Other | N/A | | | | | |
| | | | 115 VAC | | 230 VAC | | 100 VAC |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| Energy Consumption | Windows Idle (S0) | 42.323 | | 41.338 | | 42.585 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 90.231 | | 92.323 | | 90.786 | |
| | Sleep (S3) | 3.449 | 3.440 | 3.566 | 3.558 | 3.530 | 3.410 |
| | Off (S5) | 1.041 | 1.014 | 1.242 | 1.231 | 1.310 | 1.180 |
| | Zero Power Mode (ErP) | 0.187 | | 0.43 | | 0.174 | |
| | | | 115 VAC | | 230 VAC | | 100 VAC |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| Heat Dissipation (Btu/hr) | Windows Idle (S0) | 144.406 | | 141.045 | | 145.301 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 307.868 | | 315.006 | | 309.761 | |
| | Sleep (S3) | 11.767 | 11.737 | 12.167 | 12.140 | 12.044 | 11.634 |
| | Off (S5) | 3.551 | 3.459 | 4.237 | 4.200 | 4.469 | 4.026 |
| | Zero Power Mode (ErP) | 0.638 | | 1.467 | | 0.594 | |
| | | | 115 VAC | | 230 VAC | | 100 VAC |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |

| | | | | | | | |
|---|-----------------------|---|--------------|-------------|--------------|-------------|--------------|
| Example Z4 G4 Workstation Configuration #2 ENERGY STAR® Certified | Processor | 1x Intel Xeon W-2123 4C 3.6GHz | | | | | |
| | Memory | 2x 8GB DDR4-2666 (Registered DIMM) | | | | | |
| | Graphics | 1x NVIDIA QuadroP1000 | | | | | |
| | Disks / Optical | 1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA | | | | | |
| | Power Supply | 750W 90% custom PSU | | | | | |
| | Other | N/A | | | | | |
| | | | 115 VAC | | 230 VAC | | 100 VAC |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| Energy Consumption (Watts) | Windows Idle (S0) | 39.947 | | 39.569 | | 40.956 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 149.543 | | 150.789 | | 147.845 | |
| | Sleep (S3) | 3.615 | 3.566 | 3.801 | 3.798 | 3.634 | 3.621 |
| | Off (S5) | 1.079 | 1.016 | 1.440 | 1.238 | 1.320 | 1.170 |
| | Zero Power Mode (ErP) | 0.204 | | 0.430 | | 0.191 | |
| | | | 115 VAC | | 230 VAC | | 100 VAC |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |

| | | | | | | | |
|--|--|-------------|--------------|-------------|--------------|-------------|--------------|
| | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |

System Technical Specifications

| | | LAN Enabled | | LAN Disabled | | LAN Enabled | | LAN Disabled | | LAN Enabled | |
|-------------------------------------|-----------------------|-------------|--------------|--------------|--------------|-------------|--------------|--------------|--------------|-------------|--------------|
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| Heat Dissipation (Btu/hr) | Windows Idle (S0) | 136.299 | | 135.009 | | 139.741 | | | | | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | | | | | |
| | Windows Busy Max (S0) | 510.241 | | 514.492 | | 504.447 | | | | | |
| | Sleep (S3) | 12.338 | 12.167 | 12.969 | 12.959 | 12.399 | 12.355 | | | | |
| | Off (S5) | 3.681 | 3.466 | 4.913 | 4.224 | 4.504 | 3.992 | | | | |
| | Zero Power Mode (ErP) | 0.696 | | 1.467 | | 0.651 | | | | | |

| | | | | | | | | | | | |
|---|-----------------------|---|-------------|--------------|-------------|--------------|-------------|--------------|--|--|--|
| Example Z4 G4 Workstation Configuration #3 | Processor | 1x Intel Xeon W-2133 6C 3.6GHz | | | | | | | | | |
| | Memory | 4x 8GB DDR4-2666 (Registered DIMM) | | | | | | | | | |
| | Graphics | 1x NVIDIA QuadroP2000 | | | | | | | | | |
| | Disks/Optical | 2x 1TB SATA7200 ; 1x Slim SuperMulti DVDRW SATA | | | | | | | | | |
| | Power Supply | 750W 90% custom PSU | | | | | | | | | |
| | Other | N/A | | | | | | | | | |
| Energy Consumption (Watts) | | | 115 VAC | | 230 VAC | | 100 VAC | | | | |
| | | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | | | |
| | Windows Idle (S0) | 48.759 | | 46.321 | | 46.578 | | | | | |
| | Windows Busy Typ(S0) | TBD | | 199.56 | | 206.055 | | | | | |
| | Windows Busy Max (S0) | 209.60 | | 208.66 | | 198.82 | | | | | |
| | Sleep (S3) | 4.360 | 4.351 | 4.538 | 4.508 | 4.299 | 4.277 | | | | |
| | Off (S5) | 1.039 | 1.017 | 1.42 | 1.219 | 1.015 | 0.997 | | | | |
| | Zero Power Mode (ErP) | 0.203 | | 0.399 | | 0.191 | | | | | |
| Heat Dissipation (Btu/hr) | | | 115 VAC | | 230 VAC | | 100 VAC | | | | |
| | | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | | | |
| | Windows Idle (S0) | 166.366 | | 258.047 | | 158.924 | | | | | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | | | | | |
| | Windows Busy Max (S0) | 715.155 | | 711.947 | | 678.373 | | | | | |
| | Sleep (S3) | 14.876 | 14.845 | 15.483 | 15.381 | 14.668 | 14.593 | | | | |
| | Off (S5) | 3.544 | 3.470 | 4.845 | 4.179 | 3.463 | 3.402 | | | | |
| | Zero Power Mode (ErP) | 0.692 | | 1.361 | | 0.651 | | | | | |

System Technical Specifications

| | | | | | | | |
|---|-----------------------|-------------------------------------|--------------|-------------|--------------|--------------|--------------|
| Example Z4 G4 Workstation Configuration #4 | Processor | 1x Intel Xeon W-2155 10C 3.3GHz | | | | | |
| | Memory | 8x 32GB DDR4-2666 (Registered DIMM) | | | | | |
| | Graphics | 1x NVIDIA QuadroP6000 | | | | | |
| | Disks / Optical | 4x 2TB SATA 7200 ; 0x ODD | | | | | |
| | Power Supply | 750W 90% custom PSU | | | | | |
| | Other | N/A | | | | | |
| Energy Consumption (Watts) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows Idle (S0) | 65.959 | | 69.321 | | 68.635 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 463.23 | | 456.95 | | 503.125 | |
| | Sleep (S3) | 6.336 | 6.102 | 6.971 | 6.189 | 6.266 | 6.264 |
| | Off (S5) | 1.047 | 1.036 | 1.254 | 1.222 | 1.014 | 0.995 |
| | Zero Power Mode (ErP) | 0.203 | | 0.399 | | 0.191 | |
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (S0) | 225.052 | | 236.523 | | 234.183 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 1580.541 | | 1559.113 | | 1716.663 | |
| | Sleep (S3) | 21.618 | 20.821 | 23.785 | 21.117 | 21.379 | 21.372 |
| | Off (S5) | 3.572 | 3.534 | 4.278 | 4.169 | 3.459 | 3.394 |
| | Zero Power Mode (ErP) | 0.692 | | 1.361 | | 0.652 | |

| | | | | | | | |
|---|-----------------------|---|--------------|-------------|--------------|--------------|--------------|
| Example Z4 G4 Workstation Configuration #5 | Processor | 1x Intel Core i7-7800X 3.5GHz 6C | | | | | |
| | Memory | 2x 8GB DDR4-2666 (non-ECC DIMM) | | | | | |
| | Graphics | 1x NVIDIA Quadro P1000 | | | | | |
| | Disks / Optical | 1x 1TB SATA 7200 : 1x Slim DVD-ROM SATA | | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | | |
| | Other | N/A | | | | | |
| Energy Consumption (Watts) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows Idle (S0) | 46.909 | | 47.175 | | 46.909 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 201.83 | | 199.97 | | 203.41 | |
| | Sleep (S3) | 3.041 | 2.971 | 3.165 | 3.041 | 2.971 | 3.165 |
| | Off (S5) | 0.978 | 0.898 | 1.159 | 0.978 | 0.898 | 1.159 |
| | Zero Power Mode (ErP) | 0.199 | | 0.379 | | 0.187 | |
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (S0) | 160.053 | | 160.961 | | 160.053 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 688.644 | | 682.297 | | 694.035 | |
| | Sleep (S3) | 10.376 | 10.137 | 10.799 | 10.376 | 10.137 | 10.799 |
| | Off (S5) | 3.337 | 3.064 | 3.954 | 3.337 | 3.064 | 3.954 |

System Technical Specifications

| | | | | |
|--|-----------------------|-------|-------|-------|
| | Zero Power Mode (ErP) | 0.678 | 1.293 | 0.638 |
|--|-----------------------|-------|-------|-------|

| | | | | | | | |
|---|-----------------|---|--|--|--|--|--|
| Example Z4 G4 Workstation Configuration #6 | Processor | 1x Intel Core i7-7920X 2.9GHz 12C | | | | | |
| | Memory | 4x 16GB DDR4-2666 (non-ECC DIMM) | | | | | |
| | Graphics | 1x NVIDIA Quadro P4000 | | | | | |
| | Disks / Optical | 2x 2TB SATA 7200 : 1x Slim DVD-ROM SATA | | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | | |
| | Other | N/A | | | | | |

| | | | | | | | |
|--------------------------------------|-----------------------|-------------|--------------|-------------|--------------|-------------|--------------|
| Energy Consumption (Watts) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows Idle (S0) | 53.392 | | 51.332 | | 53.367 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 318.58 | | 307.82 | | 319.71 | |
| | Sleep (S3) | 3.558 | 3.486 | 3.694 | 3.558 | 3.486 | 3.694 |
| | Off (S5) | 0.972 | 0.895 | 1.160 | 0.972 | 0.895 | 1.160 |
| | Zero Power Mode (ErP) | 0.201 | | 0.391 | | 0.186 | |

| | | | | | | | |
|-------------------------------------|-----------------------|-------------|--------------|-------------|-------------|--------------|-------------|
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (S0) | 182.174 | | 175.144 | | 182.088 | |
| | Windows Busy Typ(S0) | TBD | | TBD | | TBD | |
| | Windows Busy Max (S0) | 1086.994 | | 1050.281 | | 1090.851 | |
| | Sleep (S3) | 12.139 | 11.894 | 12.604 | 12.139 | 11.894 | 12.604 |
| | Off (S5) | 3.316 | 3.054 | 3.957 | 3.316 | 3.054 | 3.957 |
| | Zero Power Mode (ErP) | 0.685 | | 1.334 | | 0.634 | |

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

Declared Noise Emissions

| Declared Noise Emissions (Entry-level and High-end configurations) | | |
|--|-----------------------|---|
| System Configuration (Entry level) | Processor Info | Intel® Xeon® W-2125 4.0 2666 4C CPU |
| | Memory Info | 32GB (4x8GB) DDR4-2666 ECC Reg RAM |
| | Graphics Info | 1-NVIDIA® Quadro® P400 2GB |
| | Disks/Optical | 1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 465 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|---|-------------------------------------|--|
| | Idle | 13 |
| | Hard drive Operating (random reads) | 15 |

System Technical Specifications

| | | |
|--|-----------------------|--|
| System Configuration (High end) | Processor Info | Intel® Xeon® W-2155 3.3 2666 10C |
| | Memory Info | 128GB (8x16GB) DDR4-2666 ECC Reg RAM |
| | Graphics Info | 1-NVIDIA® Quadro® P6000 24GB |
| | Disks/Optical | 2-4TB SATA 7200RPM Ent 3.5"? / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 750 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|--|---|------------------------------------|--|
| | Idle | 3.5 | 22 |
| | Hard drive Operating (random reads) | 3.7 | 23 |

| | | |
|---|-----------------------|--|
| System Configuration (Entry Level 2) | Processor Info | Intel® Core i9-7900X 3.3 2666 10C |
| | Memory Info | 32GB (4x8GB) DDR4-2666 nECC RAM |
| | Graphics Info | 1-NVIDIA® Quadro® P400 2GB |
| | Disks/Optical | 1-500GB SATA 7200RPM Ent 3.5"? / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|--|---|------------------------------------|--|
| | Idle | 3.4 | 16 |
| | Hard drive Operating (random reads) | 3.5 | 17 |

| | | |
|--|-----------------------|--|
| System Configuration (High end 2) | Processor Info | Intel®Core i9-7980XE 2.6 2666 18C |
| | Memory Info | 128GB (8x16GB) DDR4-2666 nECC RAM |
| | Graphics Info | 1-NVIDIA® Quadro® P6000 24GB |
| | Disks/Optical | 2-4TB SATA 7200RPM Ent 3.5"? / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|--|---|------------------------------------|--|
| | Idle | 3.5 | 20 |
| | Hard drive Operating (random reads) | 3.7 | 21 |

System Technical Specifications

NOTE: Higher noise levels may be experienced with non-HP approved graphic card(s). Some consumer graphics cards have side blowing that may heat up thermal sensor(s) on the mother board causing fans to ramp.

Environmental Data

| | | |
|-----------------------------------|-------------------------------|--|
| Environmental Requirements | Temperature | Non-operating: -40° to 60° C (-40° to 140° F) Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Maximum rate of change: 10 °C/hr No direct sustained sunlight |
| | Humidity | Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb |
| | Maximum Altitude | Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details. |
| | Shock (non-repetitive) | Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) Non-operating square: 422 cm/s, 20g |
| | Vibration | Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g ² /Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g ² /Hz |

Physical Security and Serviceability

| | |
|--|---|
| Access Panel | Tool-less Includes system board and memory information. |
| Hard Drives | Tool-less |
| Expansion Cards | Tool-less |
| Processor Socket | Tool-less |
| Blue User Touch Points | Yes, on primary serviceable components. |
| Color-coordinated Cables and Connectors | Yes |
| Memory | Tool-less |
| System Board | Screw-In |
| Dual Color Power/Failure LED | Yes |
| HDD Activity LED | Yes Note: HDD Activity LED is not dual-color |
| Configuration Record SW | Yes |
| Over-Temp Warning on Screen | Yes, at POST screen on reboot |
| Restore CD/DVD Set | Restores the computer to its original factory shipping image; can be obtained via HP Support. |

System Technical Specifications

| Dual Function Front Power Switch | Yes, causes a fail-safe power off when held for 4 seconds | | | | | | |
|---|--|---------------------------------|----------------------------------|---|---|---|---|
| Padlock Support | Yes (optional): Locks side cover and secures chassis from theft 7.0 mm (0.2756 in) diameter padlock loop at rear of system | | | | | | |
| Cable Lock Support | Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system | | | | | | |
| Universal Chassis Clamp Lock Support | Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units chained together when used with optional cable Threaded feature at rear of system | | | | | | |
| Solenoid Lock and Hood Sensor | Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when access panel has been removed | | | | | | |
| Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control | Yes, enables or disables serial, USB, audio, and network ports | | | | | | |
| Removable Media Write/Boot Control | Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media) | | | | | | |
| Power-On Password Setup Password | Yes, prevents an unauthorized person from booting up the workstation Yes, prevents an unauthorized person from changing the workstation configuration | | | | | | |
| 3.3V Aux Power LED on System PCA | Yes | | | | | | |
| NIC LEDs (integrated) (Green & Amber) | Yes | | | | | | |
| CPUs and Heatsinks | A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less | | | | | | |
| Power Supply Diagnostic LED/s | | | | | | | |
| Front Power Button | Yes, ACPI multi-function | | | | | | |
| Rear Power Button | Yes | | | | | | |
| Front Power LED | Yes, white (normal), red (fault) | | | | | | |
| Front Hard Drive Activity LED | Yes, white | | | | | | |
| Front ODD Activity LED | Yes, on device | | | | | | |
| Internal Speaker | Yes | | | | | | |
| System/Emergency ROM Flash Recovery | Recovers corrupted system BIOS. | | | | | | |
| Cooling Solutions | Air cooled forced convection heatsinks | | | | | | |
| Power Supply Fans | 80 mm x 80 mm x 25 mm (non-serviceable) | | | | | | |
| CPU Heatsink Fan | <table border="0" style="width: 100%;"> <thead> <tr> <th style="text-align: left;">Intel® Xeon® W Processor Family</th> <th style="text-align: left;">Intel® Core™ X-series Processors</th> </tr> </thead> <tbody> <tr> <td>CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5-wire, PWM</td> <td>CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5-wire, PWM</td> </tr> <tr> <td>CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter)</td> <td>CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter)</td> </tr> </tbody> </table> | Intel® Xeon® W Processor Family | Intel® Core™ X-series Processors | CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5-wire, PWM | CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5-wire, PWM | CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter) | CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter) |
| Intel® Xeon® W Processor Family | Intel® Core™ X-series Processors | | | | | | |
| CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5-wire, PWM | CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5-wire, PWM | | | | | | |
| CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter) | CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-wire, PWM (includes 6-to-5pin cable adapter) | | | | | | |
| Chassis Fan | <p>Front: (Optional) 92 mm x 92mm x 25 mm, 4-wire, PWM</p> <p>Rear: 120 mm x 120mm x 25 mm, 4-wire, PWM</p> | | | | | | |
| Memory Heatsink Fan | Dual 60 mm x 60 mm x 25 mm, 6-wire, PWM, Blindmate (optional based on configuration) | | | | | | |

System Technical Specifications

| | |
|---|--|
| HP PC Hardware Diagnostics UEFI | HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available as a download from HP Support. |
| Access Panel Key Lock | Yes, side panel barrel keylock (optional from the factory only) |
| ACPI-Ready Hardware | Advanced Configuration and Power Management Interface (ACPI). <ul style="list-style-type: none"> Allows the system to wake from a low-power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system |
| Trusted Platform Module Chip | Infineon TPM 2.0 Certified |
| Integrated Chassis Handles | Yes, Front handle and dedicated rear recess |
| Power Supply | Requires T15 Torx or flat blade screwdriver |
| PCIe Card Retention | Yes, rear (all), middle (all), front (full-length cards with extender, using HP Z4 G4 Fan and Front Card Guide Kit) |
| Flash ROM | Yes |
| Diagnostic Power Switch LED on board | Yes |
| Clear Password Jumper | Yes |
| Clear CMOS Button | Yes |
| CMOS Battery Holder | Yes |
| DIMM Connectors | Yes |

BIOS

| | |
|--|--|
| BIOS 32-bit Services | Standard BIOS 32-bit Service Directory Proposal v0.4 |
| PCI 3.0 Support | Full BIOS support for PCI Express through industry standard interfaces. |
| ATAPI | ATAPI Removable Media Device BIOS Specification Version 1.0. |
| BBS | BIOS Boot Specification v1.01. |
| WMI Support | WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications. |
| BIOS Boot Spec 1.01+ | Provides more control over how and from what devices the workstation will boot. |
| BIOS Power On | Users can define a specific date and time for the system to power on. |
| ROM Based Computer Setup Utility (F10) | Review and customize system configuration settings controlled by the BIOS. |
| System/Emergency ROM Flash Recovery with Video Replicated Setup | Recovers system BIOS in corrupted Flash ROM. Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigUtility.exe utility can replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup). |
| SMBIOS | System Management BIOS 2.8, for system management information. |
| Boot Control | Disables the ability to boot from removable media on supported devices. |
| Memory Change Alert | Alerts management console if memory is removed or changed. |
| Thermal Alert | Monitors the temperature state within the chassis. Three modes: <ul style="list-style-type: none"> NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. |
| Remote ROM Flash | Provides secure, fail-safe ROM image management from a central network console. |

System Technical Specifications

| | |
|---|--|
| ACPI (Advanced Configuration and Power Management Interface) | Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 5.0 for full compatibility with 64-bit operating systems. |
| Ownership Tag | A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. |
| Remote Wakeup/Remote Shutdown | System administrators can power on, restart, and power off a client computer from a remote location with Intel Xeon W Processors. For systems with Intel Core X-Series Processors, Wake on LAN is supported, however to remotely restart or shutdown a system, a remote desktop application must be used to manually Restart or Shutdown. |
| Instantly Available PC (Suspend to RAM - ACPI sleep state S3) | Allows for very low power consumption with quick resume time. |
| Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server) | Allows a new or existing system to boot over the network and download software, including the operating system. |
| ROM revision levels | Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through the industry standard interface (SMBIOS and WMI) so that management SW applications can use and report this information. |
| System board revision level | Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified. |
| Start-up Diagnostics (Power-on Self-Test) | Assesses system health at boot time with selectable levels of testing. |
| Auto Setup when new hardware installed | System automatically detects addition of new hardware. |
| Keyboard-less Operation | The system can be booted without a keyboard. |
| Localized ROM Setup | Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local keyboard mappings. |
| Asset Tag | The user or MIS to set a unique tag string in non-volatile memory. |
| Per-slot Control | Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. |
| Adaptive Cooling | Control parameters are set according to detected hardware configuration for optimal acoustics. |
| Pre-boot Diagnostics | (Pre-video) critical errors are reported via beeps and blinks on the power LED. |
| Industry Standard Specification Support | |
| Industry Standard UEFI Specification Revision | Revision Supported by the BIOS 2.6 |
| ACPI | Advanced Configuration and Power Management Interface, Version 5.0 |
| ATA (IDE) | ATA Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b |
| CD Boot | "El Torito" Bootable CD-ROM Format Specification Version 1.0 |
| EDD | - Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0 |
| EHCI | Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 |
| PCI | PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7 |
| PCI Express | PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 |
| PMM | POST Memory Manager Specification, Version 1.01 |
| SATA | Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 |
| SPD | PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B |

System Technical Specifications

| | |
|---------------|---|
| TPM | Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670) Common Criteria EAL4+ Certified FIPS 140-2 Certified TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/ |
| UHCI | Universal Host Controller Interface Design Guide, Revision 1.1 |
| USB | Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 G1 Specification Universal Serial Bus Revision 3.1 G2 Specification |
| SMBIOS | System Management BIOS Reference Specification, Version 2.8 |

External BIOS simulator found at: <http://h20464.www2.hp.com/index.html>

Social and Environmental Responsibility

Eco-Label Certifications & Declarations This product has received or is in the process of being certified to the following approvals and may be labeled or more of these marks:

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- The ECO declaration (TED)

The Z4 G4 is registered EPEAT® Silver in the US and Canada. EPEAT® registration varies by country. See <http://www.epeat.net> for registration status by country. Search keyword generator on HP's 3rd party option for solar generator accessories at <http://www.hp.com/go/options>

Batteries

The battery in this product complies with EU Directive 2006/66/EC

Battery mass: 3g

Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage This product meets the material restrictions specified in HP's General Specification for the Environment.

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the Euro Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis

Low Halogen Statement This product is low-halogen except for power cords, external cables and peripherals. Service parts obtained at purchase may not be low-halogen.

End-of-Life Management and Recycling HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/recycle> or contact your nearest HP sales office. Products returned will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

HP Inc. Corporate Environmental Information For more information about HP's commitment to the environment: [Sustainability Report](#)

[Eco-label certifications ISO 14001 certificates](#)

Additional Information

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC. [Product Disassembly Instructions](#)
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

Packaging HP Workstation product packaging meets the [HP's General Specification for the Environment](#)

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)

System Technical Specifications

- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting
- A multi-unit eco packaging option is available to institutional customers that uses less packaging material, has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details.

Packaging Materials

Internal

Cushions and plastic bags made of low density polyethylene (LDPE).

External

Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability

Industry Standard Specifications

Intel® Xeon® W Processor Family

This product meets the following industry standard specifications for manageability functionality:

- DASH 1.1 (via Intel® LAN on motherboard)

Intel® Core™ X-series Processors

None apply

Intel Active Management Technology (AMT)

Intel® Active Management Technology (AMT) 11.1x
An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.1x includes the following advanced management functions:

- Power Management (on, off, reset, graceful shutdown, sleep and hibernate)
 - Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS and firmware revisions)
- Hardware Alerting
- Agent Presence
- System Defense Filters
- Serial Over LAN (SOL)
- USB Redirect (Media Redirection)
- ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts - automatically alert IT or service provider if issues arise
- Access Monitor - Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration

System Technical Specifications

- Management Engine (ME) firmware roll back
- Local Time Sync to UTC
- Remote Memory Dump Command - Creates memory dump for debug

Intel® vPro™ Technology The HP Z4 G4 Workstation supports Intel® vPro™ technology when configured as outlined below: Not supported

- Intel® Xeon® processor W-2100 product family featuring Intel® vPro™ Technology
- Intel® C422 chipset
- Intel® I219LM GbE LAN

Remote Manageability Software Solutions The HP Z4 G4 Workstation is supported on the following optional remote manageability software consoles: • Microsoft System Center Configuration Manager

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager

For questions or support for manageability needs, please visit

<http://www.hp.com/go/easydeploy>

System Software Manager For easydeploy questions or support for SSM, please visit: <http://www.hp.com/go/ssm>

Service, Support, and Warranty

On-site Warranty and Service (**Note 1**): Three-years, limited warranty and service offering delivers on-site, next business-day (**Note 2**) service for parts and labor and includes free telephone support (**Note 3**) 8am - 5pm. Global coverage (**Note 2**) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercial reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/lookuptool>. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers—no special programs, no additional cost—no kidding. Simply select your hardware components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors

Intel® Xeon® W-2125 4.0 2666 4C CPU
Intel® Xeon® W-2123 3.6 2666 4C CPU

Hard Drives

1TB SATA 7200 RPM

Graphics

AMD Radeon™ Pro WX 3100 4GB Graphics
NVIDIA® Quadro® P400 2GB Graphics
NVIDIA® Quadro® P1000 4GB Graphics
NVIDIA® Quadro® P2000 5GB Graphics

Technical Specifications - Processors

Intel® Xeon® W-Series CPU

Intel® Xeon® W-2295 3.0 2933 18C CPU

Intel® Xeon® W-2275 3.3 2933 14C CPU

Intel® Xeon® W-2265 3.5 2933 12C CPU

Intel® Xeon® W-2255 3.7 2933 10C CPU

Intel® Xeon® W-2245 3.9 2933 8C CPU

Intel® Xeon® W-2235 3.8 2933 6C CPU

Intel® Xeon® W-2225 4.1 2933 4C CPU

Intel® Xeon® W-2223 3.6 2933 4C CPU

Intel® Xeon® W-2145 3.7 2666 8C CPU

Intel® Xeon® W-2133 3.6 2666 6C CPU

Intel® Xeon® W-2125 4.0 2666 4C CPU

Intel® Xeon® W-2123 3.6 2666 4C CPU

Intel® Xeon® W-2104 3.2 2400 4C CPU

Intel® Xeon® W-2102 2.9 2400 4C CPU

Intel® Core™ X-Series CPU

Intel® Core™ i9-10980XE 3.0 2933 18C CPU

Intel® Core™ i9-10940X 3.3 2933 14C CPU

Intel® Core™ i9-10920X 3.5 2933 12C CPU

Intel® Core™ i9-10900X 3.7 2933 10C CPU

Intel® Core™ i7-9800X 3.8 2666 8C CPU

Technical Specifications - Hard Drives

Storage/Hard Drives

| | | | | | |
|--|---------------------------------|--|---|----------------|--|
| HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations | HP 300GB SAS 15K SFF HDD | Capacity | 300GB | | |
| | | Height | 5.9 in; 15 cm | | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm | |
| | | Interface | 12Gb/s SAS | | |
| | | Synchronous Transfer Rate | Up to 1200 MB/s (SAS single port)* (Maximum) | | |
| | | Buffer | 128MB | | |
| | | Seek Time (typical reads, includes controller overhead, including settling) | Average | 2.0ms * | |
| | | Rotational Speed | 15K rpm | | |
| | | Operating Temperature | 41° to 131° F (5° to 55° C) | | |
| | | <i>*Actual performance may vary.</i> | | | |

| | | | | | |
|--|---|--|-----------------------------------|----------------|--|
| SATA (Serial ATA) Hard Drives for HP Workstations | 500GB SATA 7200 rpm 6Gb/s 3.5" HDD | Capacity | 500GB | | |
| | | Height | 1 in; 2.54 cm | | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm | |
| | | | Physical Size | 4 in; 10.17 cm | |
| | | Interface | Serial ATA (6.0Gb/s), NCQ enabled | | |
| | | Synchronous Transfer Rate | Up to 600MB/s* (Maximum) | | |
| | | Buffer | 16MB | | |
| | | Seek Time (typical reads, includes controller overhead, including settling) | Single Track | 2 ms* | |
| | | | Average | 11 ms* | |
| | | | Full Stroke | 21 ms* | |
| | | Rotational Speed | 7,200 rpm | | |
| | | Logical Blocks | 976,773,168 | | |
| | | Operating Temperature | 41° to 131° F (5° to 55° C) | | |
| | <i>*Actual performance may vary.</i> | | | | |

| | | | | | |
|--|---|----------------------------------|-----------------------------------|----------------|--|
| | 1TB SATA 7200 rpm 6Gb/s 3.5" HDD | Capacity | 1TB | | |
| | | Height | 1 in; 2.54 cm | | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm | |
| | | | Physical Size | 4 in; 10.17 cm | |
| | | Interface | Serial ATA (6.0Gb/s), NCQ enabled | | |
| | | Synchronous Transfer Rate | Up to 600 MB/s* (Maximum) | | |
| | | Buffer | 64MB | | |
| | | Cache | Adaptive | | |

Technical Specifications - Hard Drives

| | | |
|---|---------------------|--------|
| Seek Time (typical reads, includes controller overhead including settling) | Single Track | 2 ms* |
| | Average | 11 ms* |
| | Full Stroke | 21 ms* |

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

*Actual performance may vary.

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD CMR

| | |
|------------------|--------------------------------------|
| Capacity | 2.0TB |
| Height | 1 in; 2.54 cm |
| Width | Media Diameter 3.5 in; 8.9 cm |
| | Physical Size 4 in; 10.17 cm |
| Interface | Serial ATA (6.0 Gb/s), NCQ Enabled |

Synchronous Transfer Rate Up to 600 MB/s*
(Maximum)

Buffer 64MB

| | | |
|---|---------------------|---------|
| Seek Time (typical reads, includes controller overhead including settling) | Single Track | 1.0 ms* |
| | Average | 11 ms* |
| | Full Stroke | 18 ms* |

Rotational Speed 7,200 rpm

Logical Blocks 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

*Actual performance may vary.

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR

| | |
|------------------|--------------------------------------|
| Capacity | 2.0TB |
| Height | 1 in; 2.54 cm |
| Width | Media Diameter 3.5 in; 8.9 cm |
| | Physical Size 4 in; 10.17 cm |
| Interface | Serial ATA (6.0 Gb/s), NCQ Enabled |

Synchronous Transfer Rate Up to 600 MB/s*
(Maximum)

Buffer 64MB

| | | |
|---|---------------------|---------|
| Seek Time (typical reads, includes controller overhead including settling) | Single Track | 1.2 ms* |
| | Average | 12 ms* |
| | Full Stroke | 21 ms* |

Rotational Speed 7,200 rpm

Logical Blocks 3,907,029,168

Operating Temperature 41° to 140° F (5° to 60° C)

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | | |
|--|---|---------------------------------|----------------|--|
| 1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Capacity | 1TB | | |
| | Protocol | SATA | | |
| | Form Factor | 3.5" | | |
| | Controller | AHCI | | |
| | Reliability (MTBF) | 2.0M hours | | |
| | Rated Power On Hours | 8760/yr | | |
| | Annualized Failure Rate (based on Rated POH) | <0.62% | | |
| | Rated for 24/7/365 operation | YES | | |
| | Physical Size (Height) | 1 in; 2.54 cm | | |
| | Physical Size (Width) | 4 in; 10.17 cm | | |
| | Media Diameter | 3.5 in; 8.9 cm | | |
| | Interface | Serial ATA (6Gb/s), NCQ enabled | | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | | |
| | Buffer | 128MB | | |
| | Seek Time (typical reads, includes controller overhead including settling) | Single Track | 0.32ms* | |
| | | Average | 7.45ms* | |
| | | Full Stroke | 14.2ms* | |
| | Operating Temperature | 41° to 140° F (5° to 60° C) | | |
| | Performance | Sequential Read | up to 226MB/s* | |
| | | Sequential Write | up to 226MB/s* | |
| Enterprise Class Features | High Reliability | | | |

*Actual performance may vary.

| | | | | |
|--|---|---------------------------------|---------|--|
| 4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Capacity | 4TB | | |
| | Height | 0.275 in; 0.7 cm | | |
| | Width | 2.5 in; 6.36 cm | | |
| | Media Diameter | 2.5 in; 6.36 cm | | |
| | Physical Size | 2.75 in; 6.99 cm | | |
| | Interface | Serial ATA (6Gb/s), NCQ enabled | | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | | |
| | Buffer | 128MB | | |
| | Seek Time (typical reads, includes controller overhead including settling) | Single Track | 0.7ms* | |
| | | Average | 8.5ms* | |
| | | Full Stroke | 15.7ms* | |
| | Rotational Speed | 7,200 rpm | | |
| | Operating Temperature | 32° to 140° F (0° to 60° C) | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|------------------------------------|---|-----------------------------|---------------------------------------|
| 500GB SATA 7.2K SED SFF HDD | Capacity | 500GB | |
| | Height | 0.275 in; 0.7 cm | |
| | Width | | Media Diameter 2.5 in; 6.36 cm |
| | | | Physical Size 2.75 in; 6.99 cm |
| | Interface | Serial ATA (6Gb/s) | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Buffer | 32MB | |
| | Seek Time (typical reads, includes controller overhead including settling) | Single Track | 1ms* |
| | | Average | 4.2ms* |
| | | Full Stroke | 25ms (typical)* |
| | Rotational Speed | 7,200 rpm | |
| | Operating Temperature | 32° to 140° F (0° to 60° C) | |

*Actual performance may vary.

SATA SSDs for HP Workstations

| | | | | |
|--------------------------------|--|-----------------------------|-----------------|--|
| HP 256GB SATA 6Gb/s SSD | Capacity | 256GB | | |
| | Protocol | SATA | | |
| | Form Factor | 2.5" | | |
| | Controller | AHCI | | |
| | NAND Type | 3D TLC | | |
| | Endurance | 192TBW (TB Written) | | |
| | Reliability (MTTF) | 1.5M hours | | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | | |
| | Interface | SATA 6Gb/s | | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 530MB/s (max)* | |
| | | Sequential Write | 500MB/s (max)* | |
| | | Random Read | 55K IOPS (max)* | |
| Random Write | | 83K IOPS (max)* | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|---|--|----------------------------------|-----------|
| HP 256GB SATA 6Gb/s SED Opal 2 SSD | Capacity | 256GB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 192TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | 6Gb/s SATA | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 530MB/s* |
| | | Sequential Write | 500 MB/s* |
| | | Random Read | 55K IOPS* |
| | | Random Write | 83K IOPS* |
| Self-Encrypting Drive Support | OPAL 2 | | |

*Actual performance may vary.

| | | | |
|--------------------------------|--|----------------------------------|-----------|
| HP 512GB SATA 6Gb/s SSD | Capacity | 512GB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 388TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s* |
| | | Random Read | 95K IOPS* |
| | | Random Write | 83K IOPS* |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|--------------------------------------|--|-----------------------------|-----------|
| HP 512GB SATA SED SSD | Capacity | 512GB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 388TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s* |
| | | Random Read | 95K IOPS* |
| Random Write | | 83K IOPS* | |
| Self-Encrypting Drive Support | OPAL 1 and 2 | | |

*Actual performance may vary.

| | | | |
|------------------------------|--|----------------------------------|-----------|
| HP 1TB SATA 6Gb/s SSD | Capacity | 1TB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s* |
| | | Random Read | 95K IOPS* |
| Random Write | | 83K IOPS* | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | | |
|------------------------------|--|----------------------------------|------------|--|
| HP 2TB SATA 6Gb/s SSD | Capacity | 2TB | | |
| | Protocol | SATA | | |
| | Form Factor | 2.5" | | |
| | Controller | AHCI | | |
| | NAND Type | 3D TLC | | |
| | Endurance | 400TBW (TB Written) | | |
| | Reliability (MTTF) | 1.5M hours | | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | | |
| | Interface | SATA 6Gb/s | | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 530 MB/s* | |
| | | Sequential Write | 500 MB/s * | |
| | Random Read | 95K IOPS* | | |
| | Random Write | 83K IOPS* | | |

*Actual performance may vary.

| | | | | |
|---|--|-----------------------------|-----------|--|
| HP Enterprise Class 240GB SATA SSD | Capacity | 240GB | | |
| | Protocol | SATA | | |
| | Form Factor | 2.5" | | |
| | Controller | AHCI | | |
| | NAND Type | 3D TLC | | |
| | Endurance | 2,200TBW (TB Written) | | |
| | Reliability (MTTF) | 2.0M hours | | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | | |
| | Interface | 6Gb/s SATA | | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 540 MB/s* | |
| | | Sequential Write | 310 MB/s* | |
| | Random Read | 93K IOPS* | | |
| | Random Write | 48K IOPS* | | |
| Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Protection | | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|---|--|-----------------------------|-----------|
| HP Enterprise Class 480GB SATA SSD | Capacity | 480GB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 4,400TBW (TB Written) | |
| | Reliability (MTTF) | 2.0M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | 6Gb/s SATA | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 540 MB/s* |
| | | Sequential Write | 460 MB/s* |
| Random Read | | 93K IOPS* | |
| Random Write | | 74K IOPS* | |
| Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Protection | | |

*Actual performance may vary.

| | | | | |
|--|--|------------------------------|---|-------------|
| Performance PCIe SSDs for HP Workstations | HP Z Turbo Drive 256GB M.2 2280 TLC SSD | Capacity | 256GB | |
| | | Protocol | PCIe | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | SED Support | Opal 2 | |
| | | Endurance | 200TB | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | | Performance | Sequential Read | 3500 MB/s * |
| | | | Sequential Write | 2200 MB/s * |
| | | | Random Read | 240K IOPS * |
| | | | Random Write | 480K IOPS * |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | | |
|---|------------------------------|---|-------------|--|
| HP ZTurbo Drive 512GB M.2 2280 TLC SSD | Capacity | 512GB | | |
| | Protocol | PCIe | | |
| | Form Factor | M.2 | | |
| | Controller | NVMe | | |
| | NAND Type | 3D TLC | | |
| | SED Support | Opal 2 | | |
| | Endurance | 300TB | | |
| | Reliability (MTBF) | 1.5M hours | | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 3500 MB/s* | |
| | | Sequential Write | 2900 MB/s* | |
| | | Random Read | 460 K IOPS* | |
| Random Write | | 500K IOPS* | | |

*Actual performance may vary.

| | | | | |
|---|------------------------------|---|------------|--|
| HP ZTurbo Drive 1TB M.2 2280 TLC SSD | Capacity | 1TB | | |
| | Protocol | PCIe | | |
| | Form Factor | M.2 | | |
| | Controller | NVMe | | |
| | NAND Type | 3D TLC | | |
| | SED Support | Opal 2 | | |
| | Endurance | 400TB | | |
| | Reliability (MTBF) | 1.5M hours | | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 3500 MB/s* | |
| | | Sequential Write | 3000 MB/s* | |
| | | Random Read | 580K IOPS* | |
| Random Write | | 500K IOPS* | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | | |
|--|------------------------------|---|------------|--|
| HP Z Turbo Drive 2TB M.2 2280 TLC SSD | Capacity | 2TB | | |
| | Protocol | PCIe | | |
| | Form Factor | M.2 | | |
| | Controller | NVMe | | |
| | NAND Type | 3D TLC | | |
| | SED Support | Opal 2 | | |
| | Endurance | 500TB | | |
| | Reliability (MTTF) | 1.5M hours | | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 3300 MB/s* | |
| | | Sequential Write | 2400 MB/s* | |
| | | Random Read | 500K IOPS* | |
| Random Write | | 440K IOPS* | | |

*Actual performance may vary.

| | | | | |
|---|------------------------------|----------------------------------|------------|--|
| HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD | Capacity | 512GB | | |
| | Protocol | PCIe | | |
| | Form Factor | PCIe Card, Full Height PCIe Slot | | |
| | Controller | NVMe | | |
| | NAND Type | 3D TLC | | |
| | SED Support | Opal 2 | | |
| | Endurance | 200TB | | |
| | Reliability (MTBF) | 1.5M hours | | |
| | Interface | PCIe Gen3 x4 architecture | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 3500 MB/s* | |
| | | Sequential Write | 2200 MB/s* | |
| | | Random Read | 240K IOPS* | |
| Random Write | | 480K IOPS* | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|---|------------------------------|----------------------------------|-------------|
| HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD | Capacity | 1TB | |
| | Protocol | PCIe | |
| | Form Factor | PCIe Card, Full Height PCIe Slot | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 300TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCIe Gen3 x4 architecture | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 2900 MB/s* |
| | | Random Read | 460 K IOPS* |
| | | Random Write | 500K IOPS* |

*Actual performance may vary.

| | | | |
|---|------------------------------|---|------------|
| HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD | Capacity | 2TB | |
| | Protocol | PCIe | |
| | Form Factor | PCIe Card, Full Height PCIe Slot | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 400TB | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s* |
| | | Random Read | 580K IOPS* |
| | | Random Write | 500K IOPS* |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|--|------------------------------|---|------------|
| HP Z Turbo Drive Dual Pro 256GB SSD | Capacity | 256GB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 in Half-height, half-length card | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 200TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 2200 MB/s* |
| | | Random Read | 240K IOPS* |
| | | Random Write | 480K IOPS* |

*Actual performance may vary.

| | | | |
|--|------------------------------|---|-------------|
| HP Z Turbo Drive Dual Pro 512GB SSD | Capacity | 512GB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 in Half-height, half-length card | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 300TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 2900 MB/s* |
| | | Random Read | 460 K IOPS* |
| | | Random Write | 500K IOPS* |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|--|------------------------------|---|------------|
| HP Z Turbo Drive Dual Pro 1TB SSD | Capacity | 1TB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 in Half-height, half-length card | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s* |
| | | Random Read | 580K IOPS* |
| | | Random Write | 500K IOPS* |

*Actual performance may vary.

| | | | |
|--|------------------------------|---|-------------|
| HP Z Turbo Drive Dual Pro 2TB SSD | Capacity | 2TB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 in Half-height, half-length card | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 500TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s * |
| | | Random Read | 600K IOPS* |
| | | Random Write | 500K IOPS* |

*Actual performance may vary.

**Mainstream PCIe SSDs for
HP Workstations** **HP 256GB M.2 2280 TLC
SSD**

| | | |
|------------------------------|---|--------------|
| Capacity | 256GB | |
| Protocol | PCIe | |
| Form Factor | M.2 | |
| Controller | NVMe | |
| NAND Type | 3D TLC | |
| Endurance | 200TB | |
| Reliability (MTBF) | 1.5M hours | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 3100 MB/s * |
| | Sequential Write | 1400 MB/s * |
| | Random Read | 200 K IOPS * |
| | Random Write | 320 K IOPS * |

Technical Specifications - Hard Drives

*Actual performance may vary.

| | | | |
|----------------------------------|------------------------------|---|------------|
| HP 512GB M.2 2280 TLC SSD | Capacity | 512GB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 300TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2500 MB/s* |
| Random Read | | 225 K IOPS* | |
| Random Write | | 430 K IOPS* | |

*Actual performance may vary.

| | | | |
|--------------------------------|------------------------------|---|------------|
| HP 1TB M.2 2280 TLC SSD | Capacity | 1TB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2500 MB/s* |
| Random Read | | 400 K IOPS* | |
| Random Write | | 440 K IOPS* | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|--------------------------------|------------------------------|---|-------------|
| HP 2TB M.2 2280 TLC SSD | Capacity | 2TB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 500TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2700 MB/s* |
| | | Random Read | 430 K IOPS* |
| | | Random Write | 500 K IOPS* |

*Actual performance may vary.

Intel® 905p Series AIC PCIe SSD Intel® 905p Series AIC 280GB PCIe SSD

| | | | |
|---------------------|------------------------------|-----------------------------|------------|
| | Capacity | 280GB | |
| | Protocol | PCIe | |
| | Form Factor | PCIe Card, Half Height | |
| | Controller | NVMe | |
| | NVM Type | 3DXPoint | |
| | Endurance | 5.11 PBW (PB Written) | |
| | Reliability (MTBF) | 1.6M hours | |
| | Operating Temperature | 32° to 185° F (0° to 85° C) | |
| | Performance | Sequential Read | 2730 MB/s* |
| | | Sequential Write | 2280 MB/s* |
| Random Read | | 587K IOPS* | |
| Random Write | | 559K IOPS* | |

*Actual performance may vary.

Intel® 905p Series AIC 480GB PCIe SSD

| | | | |
|---------------------|------------------------------|-----------------------------|------------|
| | Capacity | 480GB | |
| | Protocol | PCIe | |
| | Form Factor | PCIe Card, Half Height | |
| | Controller | NVMe | |
| | NVM Type | 3DXPoint | |
| | Endurance | 8.76 PBW (PB Written) | |
| | Reliability (MTBF) | 1.6M hours | |
| | Operating Temperature | 32° to 185° F (0° to 85° C) | |
| | Performance | Sequential Read | 2710 MB/s* |
| | | Sequential Write | 2280 MB/s* |
| Random Read | | 582K IOPS* | |
| Random Write | | 561K IOPS* | |

*Actual performance may vary.

Technical Specifications - Hard Drive Controllers

Hard Drive Controllers

| | | | |
|--|---------------------------------------|---------------------------------------|--------------------|
| MicroSemi 2100-4i4e 8-port SAS 12Gb/s RAID Card | PCI Bus | 8 lanes, PCI Express 3.0 | |
| | RAID Levels | Offers Integrated RAID (0, 1, and 10) | |
| | PCI Data Burst Transfer Rate | Half Duplex x8, PCIe, 8000 MB/s | |
| | SAS Bandwidth | Half Duplex | 1200 MB/s per lane |
| | PCI Card Type | 3.3V Add-in Card | |
| | PCI Voltage | 12 V ± 10% | |
| | PCI Power | 9.8W typical, Airflow min 200 LFM | |
| | Bracket | Full height and low profile | |
| | Certification Level | PCI Express 3.0 compliant | |
| | SAS Processor | MicroSemi Series 8 SAS Controller | |
| | Internal Connectors | One x4 internal mini-SASHD (SFF-8643) | |
| | External Connectors | One x4 external mini-SASHD (SFF-8644) | |
| | Maximum Number of SCSI Devices | 256 Non-RAID SAS/SATA devices | |
| | LED Indicators | Connector for Drive Activity Light | |

NOTE: RAID 5 is not supported on MicroSemi 2100-4i4e 8-port SAS 12Gb/s RAID Card

Technical Specifications - Graphics

Graphics

NVIDIA® Quadro® P400 2GB Form Factor Graphics

Dimensions: 2.713"? H x 5.7"? L
 Single Slot, Low Profile
 Weight: 129 grams

| | |
|-----------------------------------|---|
| Graphics Controller | NVIDIA® Quadro® P400 Graphics Card GPU: 256 CUDA cores Power: 30 Watts Cooling: Active |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s |
| Connectors | 3mDP Outputs* |
| Maximum Resolution | DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| Display Output | 3 mDP Connectors |
| Shading Architecture | Full Microsoft DirectX 12 Shader Model 5.1 |
| Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL |
| Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux |

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

Notes *P400, P600 and P1000 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included
 After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables
- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

NVIDIA® Quadro® P620 2GB Form Factor Graphics

Dimensions: 2.713"? H x 5.7"? L
 Single Slot, Low Profile
 Weight: 129 grams

| | |
|-----------------------------------|---|
| Graphics Controller | NVIDIA® Quadro® P620 Graphics Card GPU: 512 CUDA cores Power: 40 Watts Cooling: Active |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 2 GB GDDR5, 2000 MHz Memory Interface: 128-bit Memory Bandwidth: 64 GB/s |
| Connectors | 4mDP Outputs * |
| Maximum Resolution | DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| Display Output | 4 mDP Connectors |
| Shading Architecture | Full Microsoft DirectX 12 Shader Model 5.1 |
| Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL |
| Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux |

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Notes *P620 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included
 After market option kit: Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables
- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

NVIDIA® T400 2GB Graphics

| | |
|-----------------------------------|---|
| Form Factor | Dimensions: 2.713"? H x 6.137"? L Single Slot, Low Profile Weight: 124g |
| Graphics Controller | NVIDIA® T400 Graphics Card GPU: 384 CUDA cores Power: 30 Watts Cooling: Active |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 2 GB GDDR6 Memory Interface: 64-bit Memory Bandwidth: 80 GB/s |
| Connectors | 3x mDP |
| Maximum Resolution | 3x 5120 x 2880 x 24 bpp @ 60Hz |
| Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA, OpenCL 1.x |
| Available Graphics Drivers | Windows 10 Linux |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

NVIDIA® T600 4GB Graphics Form Factor

| | |
|-----------------------------------|---|
| Form Factor | Dimensions: 2.713"? H x 6.137"? L Single Slot, Low Profile Weight: 130 grams |
| Graphics Controller | NVIDIA® T600 Graphics Card GPU: 640 CUDA cores Power: 40 Watts Cooling: Active |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 4 GB GDDR6 Memory Interface: 128-bit Memory Bandwidth: 160 GB/s |
| Connectors | 4x mDP |
| Maximum Resolution | 4x 5120 x 2880 x 24 bpp @ 60Hz |
| Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL |
| Available Graphics Drivers | Windows 10 Linux |
| | HP qualified drivers may be preloaded or available from the HP support Web site: |

Technical Specifications - Graphics

<http://welcome.hp.com/country/us/en/support.html>

NVIDIA® Quadro® P1000 4GB Form Factor Graphics

Dimensions: 2.713" H x 5.7" L
Single Slot, Low Profile
Weight: 129 grams

Graphics Controller

NVIDIA® Quadro® P1000 Graphics Card
GPU: 640 CUDA cores
Power: 47 Watts Cooling: Active
Cooling: Active

Bus Type

PCI Express 3.0 x16

Memory

Size: 4 GB GDDR5, 2500 MHz
Memory Interface: 128-bit memory interface
Memory Bandwidth: 80 GB/s memory bandwidth

Connectors

4mDP Outputs*

Maximum Resolution

DisplayPort 1.4:
- up to 4x 5120 x 2880 x 24 bpp @ 60Hz
- supports Multi-Stream Transport (MST)

Image Quality Features

10-bit internal display processing pipeline
10-bit scan-out support

Display Output

4 mDP Connectors

Shading Architecture

Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs

OpenGL 4.5
DirectX 12
Vulkan 1.0
API support includes:
CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics Drivers

Microsoft Windows 10
Microsoft Windows 8.1
Microsoft Windows 7
Linux

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Notes

*P400, P600 and P1000 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included
After market option kit: Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables
- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® P2000 5GB Graphics Form Factor

Dimensions: 4.4" H x 7.9" L
Single Slot
Weight: 260 grams

Technical Specifications - Graphics

| | |
|-----------------------------------|---|
| Graphics Controller | NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts Cooling: Active |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s Memory Width: 160-bit |
| Connectors | 4x DisplayPort™ 1.4 Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included |
| Maximum Resolution | Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready. DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz |
| Image Quality Features | 12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection) |
| Display Output | Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView. Maximum number of displays - 4 direct attached monitors Maximum number of monitors across all available NVIDIA® Quadro® P2000 outputs is 4. |
| Shading Architecture | Shader Model 5.1 |
| Supported Graphics APIs | OpenGL® 4.5 DirectX® 12 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software |
| Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and ARB extensions HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

Technical Specifications - Graphics

Notes

1. Quadro P2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
2. Quadro P2000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P2200 5GB Graphics

Form Factor

Dimensions: 4.4"?H x 7.9"?L
Single Slot, Full Height
Weight: 260 grams

Graphics Controller

NVIDIA® Quadro® P2200 Graphics Card
GPU: 1280 CUDA cores
Power: 75 Watts
Cooling: Active

Bus Type

PCI Express 3.0 x16

Memory

Size: 5GB GDDR5X
Memory Bandwidth: 200 GB/s
Memory Width: 160-bit

Connectors

4x DisplayPort™ 1.4

Factory Configured Option: No adapter included with card
After Market Option: No video cable adapter included

Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution

DisplayPort™:
- up to 5120 x 2880 x 24 bpp @ 60Hz
- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready.

DL-DVI(I) output:
- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single Link-DVI(I) output:
- up to 1920 x 1200 x 32 bpp @ 60Hz

HDMI 2.0 (requires DP to HDMI adapter):
5120 x 2880 x 24 bpp @ 60Hz

Image Quality Features

12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection)

Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView.

Display Output

Maximum number of displays
- 4 direct attached monitors

Maximum number of monitors across all available NVIDIA® Quadro® P2200 outputs is 4.

Shading Architecture

Shader Model 5.1

Supported Graphics APIs

OpenGL® 4.5
DirectX® 12

API support includes:

Technical Specifications - Graphics

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software

Available Graphics Drivers Microsoft Windows 10
Microsoft Windows 7 Professional 64bit
Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site: <http://welcome.hp.com/country/us/en/support.html>

- Notes**
1. Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
 2. Quadro P2200 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

Radeon™ Pro WX 3100 4GB Graphics Form Factor Graphics Controller

Low-Profile Single Slot (6.6" Length)

Radeon™ Pro WX 3100 Graphics Card
GPU: 512 Stream Processors organized into 8 Compute Units
Power: 50 Watts
Cooling: Active

Memory 4GB GDDR5 memory
Memory Bandwidth: 6 Gbps / 96 GB/s
Memory Width: 128 bit

Connectors 2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 - HDR ready connectors with HBR3 and MST support.

Factory Configured: No adapters included
After market option kit: One mDP-to-DP cable adapters included

Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

- 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

3x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling

Display Output 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs
FreeSync support

GPU Architecture Polaris
Supported Graphics APIs DirectX® 12
OpenGL® 4.5
OpenCL™ 2.0
Vulkan™ 1.0

Available Graphics Drivers Windows 10
(Windows® 7 64-bit available from AMD)
Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site: <http://welcome.hp.com/country/us/en/support.html>

- Notes**
1. HDR content requires that the system be configured with a fully HDR ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Technical Specifications - Graphics

2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
3. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

| | | |
|---|-----------------------------------|--|
| Radeon™ Pro WX 3200 4GB Graphics | Form Factor | Low-Profile Single Slot (2.75 "H x 6.6"? L) |
| | Graphics Controller | Radeon™ Pro WX 3200 Graphics Card GPU: 640 Stream Processors organized into 8 Compute Units Power: 56 Watts Cooling: Active |
| | Memory | 4GB GDDR5 memory Memory Bandwidth: 96 GB/s Memory Width: 128 bit |
| | Connectors | 4x Mini DisplayPort™ 1.4 - HDR ready connectors with HBR3 and MST support. Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution | 5K support @ 60Hz <ul style="list-style-type: none"> • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | GPU Architecture | Polaris |
| | Supported Graphics APIs | DirectX®12 OpenGL® 4.6 OpenCL™ 2.0 Vulkan™ 1.0 |
| | Available Graphics Drivers | Windows 10 Linux® 64-bit (selected Enterprise distributions) |
| | | HP qualified drivers may be preloaded or available from the HP support Web site http://welcome.hp.com/country/us/en/support.html |
| | Notes | <ol style="list-style-type: none"> 4. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 5. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. |

Technical Specifications - Graphics

GPU load conditions.

- As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

| | | |
|---|-----------------------------------|---|
| Radeon™ Pro WX 4100 4GB Graphics | Form Factor | Low-Profile Single Slot (6.6" Length) |
| | Graphics Controller | Radeon™ Pro WX 4100 Graphics card GPU: 1024 Stream Processors organized into 16 Compute Units Power: 50 Watts Cooling: Active |
| | Memory | 4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit |
| | Connectors | 4x Mini DisplayPort™ 1.4 - HDR ready connectors with HBR3 and MST support. Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution | 5K support @ 60Hz <ul style="list-style-type: none"> 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | GPU Architecture | GCN 4th Generation |
| | Supported Graphics APIs | DirectX® 12 OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0 |
| | Available Graphics Drivers | Windows 10 Windows® 7 64-bit Linux® 64-bit (selected Enterprise distributions) |
| | | HP qualified drivers may be preloaded or available from the HP support Web site http://welcome.hp.com/country/us/en/support.html |
| | Notes | <ol style="list-style-type: none"> HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. |

Technical Specifications - Graphics

for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included
After market option kit: Four mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option accessories:

10. 2MY05AA - HP miniDP-to-DP Adapter Cables

11. 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® T1000 4GB Graphics

Form Factor

Dimensions: 2.713"? H x 6.137"? L
Single Slot
Weight: xx

Graphics Controller

NVIDIA® T1000 Graphics Card
Power: 50W
Cooling: Active

Bus Type

PCI Express 3.0 x16

Memory

Size: 4GB GDDR6
Memory Bandwidth: Up to 160 GB/s
Memory Width: 128-bit

Connectors

4x mini DisplayPort™ 1.4a

Maximum Resolution

7680 x 4320 @ 120Hz

Display Output

Maximum number of displays: 4 displays

Architecture

NVIDIA® Turing™

Supported Graphics APIs

xx

Available Graphics Drivers

Microsoft Windows 10
Windows 8.1
Microsoft Windows 7 Professional 64bit
Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site: <http://welcome.hp.com/country/us/en/support.html>

NVIDIA® Quadro® P4000 8GB Form Factor Graphics

Dimensions: 4.4"?H x 9.5"?L
Single-slot, full-height
Weight: 475 grams (without extender)

Graphics Controller

NVIDIA® Quadro® P4000 Graphics Card
GPU: 1792 CUDA cores
Power: 120 Watts
Cooling: Active

Bus Type

PCI Express 3.0 x16

Technical Specifications - Graphics

| | |
|-----------------------------------|--|
| Memory | Size: 8GB GDDR5 Memory Bandwidth: 243 GB/s Memory Width: 256-bit |
| Connectors | 4 x DisplayPort 1.4 3-pin mini-DIN connector via optional bracket 1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II 2 x SLI connectors Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to- DVI adapters are available as accessories |
| Maximum Resolution | Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz HDMI™ 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz DisplayPort: - up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution. |
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView |
| Display Output | Maximum number of displays - 4 direct attached monitors Maximum number of monitors across all available Quadro P4000 outputs is 4. |
| Shading Architecture | Shader Model 5.1 |
| Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran |
| Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Linux® - Full OpenGL implementation, complete with NVIDIA and ARB extensions HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

Technical Specifications - Graphics

Notes

1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P5000 16GB Graphics

Form Factor

Full-Height Dual Slot (4.4" Height x 10.5" Length)
Weight: 815 grams / 1.80 lbs

Graphics Controller

NVIDIA® Quadro® P5000 graphics
GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores
Power: 180 Watts
Cooling: Active

Memory

16GB GDDR5X memory
Memory Bandwidth: Up to 288 GB/s
Memory Width: 256 bit
ECC Memory (disabled by default)

Connectors

DP (x4) with HDR support
DL-DVI(D)
3-pin mini-DIN connector
SLI connector
NVIDIA® Quadro® Sync connector (compatible with NVIDIA® Quadro® II Sync)
One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with card.
After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual Link DVI adapters available as accessories.

Maximum Resolution

5K support @ 60Hz
1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.
HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors
NVIDIA® 3D Vision™ and other 3D stereo technologies
NVIDIA Mosaic and nView Desktop Management

Display Outputs¹

4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30 Hz)
1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz)

GPU Architecture

NVIDIA Pascal™

Supported Graphics APIs

DirectX® 12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0
Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™ 1.0, Java, Python, and Fortran

Available Graphics Drivers

Windows 10
Windows® 7 64-bit
Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

Technical Specifications - Graphics

Notes 1- Supports up to a total of 4 displays

NVIDIA® Quadro® P6000 24GB Graphics

| | |
|------------------------------------|---|
| Form Factor | Full-Height Dual Slot (4.4"? Height x 10.5"? Length) Weight: 967 grams / 2.14 lbs |
| Graphics Controller | NVIDIA® Quadro® P6000 graphics GPU: 3840 NVIDIA® CUDA® Parallel Processing Cores Power: 250 Watts Cooling: Active |
| Memory | 24GB GDDR5X memory Memory Bandwidth: Up to 432 GB/s Memory Width: 384 bit ECC Memory (disabled by default) |
| Connectors | DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector SLI connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to D Link DVI adapters available as accessories. |
| Maximum Resolution | 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView |
| Display Outputs¹ | 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30 Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz) |
| GPU Architecture | NVIDIA Pascal™ |
| Supported Graphics APIs | DirectX® 12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™ Java, Python, and Fortran |
| Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| Notes | 1- Supports up to a total of 4 displays |

NVIDIA® Quadro® Form Factor Dual Slot (4.4"? Height x 10.5"? Length)

Technical Specifications - Graphics

GP100 16GB Graphics

| | |
|-----------------------------------|--|
| Graphics Controller | <p>Weight: 989 grams +72 grams extender</p> <p>NVIDIA® QUADRO® GP100</p> <p>GPU: 3584 NVIDIA CUDA® Parallel Processing Cores</p> <p>Power: 235 Watts</p> <p>Cooling: Active</p> |
| Memory | <p>16GB HBM2</p> <p>Memory Bandwidth: Up to 717 GB/s</p> <p>Memory Width: 4096-bit</p> <p>ECC Memory (disabled by default)</p> |
| Connectors | <p>DP (x4) with HDR support</p> <p>DL-DVI(D)</p> <p>3-pin mini-DIN connector via optional bracket</p> <p>4-pin header for stereo signal</p> <p>Quadro Sync connector (compatible with Quadro II Sync)</p> <p>One 8-pin auxiliary power connector</p> <p>(2x) NVLink connectors</p> <p>Factory configured option: 8-pin power adapter included with card.</p> <p>After market option Kit: 8-pin power adapter included with card.</p> <p>DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.</p> |
| Maximum Resolution | <p>5K support @ 60Hz</p> <p>1x single-cable 5K monitor, or 2x dual-cable 5K monitors</p> |
| Image Quality Features | <p>HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode)</p> <p>HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors</p> <p>NVIDIA 3D Vision™ technology</p> <p>NVIDIA Mosaic and nView Desktop Management</p> |
| Display Outputs | <p>4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz)</p> <p>1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz)</p> <p>1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz)</p> <p>HDMI™ 2.0b (up to 5120 x 2880 @ 60Hz)*</p> <p>*requires DP to HDMI adapter</p> |
| GPU Architecture | NVIDIA Pascal™ |
| Supported Graphics APIs | <p>DirectX®12 , OpenGL® 4.5, Vulkan™ 1.0</p> <p>Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran</p> |
| Available Graphics Drivers | <p>Windows® 10</p> <p>Windows® 7 Professional 64-bit</p> <p>Linux®</p> <p>HP qualified drivers may be preloaded or available from the HP support Web site:</p> <p>http://welcome.hp.com/country/us/en/support.html</p> |

Technical Specifications - Graphics

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included

After market option kit: No adapters included

NVIDIA® Quadro® GV100 32GB Graphics

Form Factor

Dual Slot (4.4" Height x 10.5" Length)
Weight: 980 grams + 72 grams extender

Graphics Controller

NVIDIA® QUADRO® GV100
GPU: 5120 NVIDIA® CUDA® Parallel Processing Cores
Power: 250 Watts
Cooling: Active

Memory

32GB HBM2 memory
Memory Bandwidth: Up to 870 GB/s
Memory Width: 5120-bit
ECC Memory (disabled by default)

Connectors

DP (x4) with HDR support
3-pin mini-DIN connector via optional bracket
4-pin header for stereo signal
Quadro Sync connector (compatible with Quadro II Sync)
One 8-pin auxiliary power connector
(2x) NVLink for GV100 connectors (via optional kit)

After market option Kit: no power adapter included with card.

DisplayPort™ to VGA, DisplayPort™ to DVI (single-link and dual-link), and DisplayPort™ to HDMI adapters available as accessories.

Maximum Resolution

5K support @ 60Hz
1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features

HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode)
HDCP 2.2 support over DisplayPort™ and HDMI connectors
NVIDIA 3D Vision™ technology
NVIDIA Mosaic and nView Desktop Management

Display Outputs

4x DP1.4 HDR2 outputs (up to 5120 x 2880 @ 60Hz)

GPU Architecture

NVIDIA® Volta™

Supported Graphics APIs

DirectX®12, OpenGL® 4.5
Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran

Available Graphics Drivers

Windows® 10 64-bit
Windows® 8 & 8.1 64-bit
Windows® 7 64-bit
Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

Technical Specifications - Graphics

Factory Configured (Z4/Z8 G4 Workstation): No adapters included
 After market option kit: No adapters included

**NVIDIA® Quadro® RTX 4000 Form Factor
 8GB Graphics**

Full-Height Single Slot (4.4" Height x 9.5" Length)
 Weight: 550 grams / 1.21 lbs

Graphics Controller

NVIDIA® Quadro® RTX 4000 Graphics
 IGPU: 2304 NVIDIA® CUDA® Parallel Processing Cores
 Power: 160 Watts
 Cooling: Active

Memory

8GB GDDR6 memory
 Memory Bandwidth: Up to 416 GB/s
 Memory Width: 384 bit

Connectors

3x DP 1.4a and VirtualLink
 Quadro Sync connector (compatible with Quadro II Sync)
 One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with card.
 After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution

7680x4320 @ 60Hz

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.
 HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors
 NVIDIA® 3D Vision™ and other 3D stereo technologies
 NVIDIA® Mosaic and nView

Display Outputs¹

3x DP 1.4a and VirtualLink² (7680x4320 @ 60Hz)

Supported Graphics APIs

DirectX® 12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0
 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran

Available Graphics Drivers

Windows® 10 64-bit
 Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

Notes

- 1- Supports up to a total of 4 displays
- 2- VirtualLink's USB-C™ (data) cannot be disabled at a hardware level

Technical Specifications - Graphics

| | | |
|--|------------------------------------|--|
| NVIDIA® RTX A4000 16GB Graphics | Form Factor | Full-Height Single Slot (4.4"? Height x 9.5"? Length) |
| | Graphics Controller | NVIDIA® RTX A4000 Graphics GPU: 6144 NVIDIA® CUDA® Parallel Processing Cores Power: 140 Watts Cooling: Active |
| | Memory | 16GB GDDR6 memory Memory Bandwidth: Up to 448 GB/s Memory Width: 256 bit |
| | Connectors | 4x DP One 6-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Display Outputs¹ | 4x DP |
| | Supported Graphics APIs | DirectX® 12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Linux® 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

| | | |
|---|---|---|
| NVIDIA® Quadro® RTX 5000 16GB Graphics | Form Factor | Full-Height Dual Slot (4.4"? Height x 10.5"? Length) Weight: 975 grams + 75 grams extender |
| | Graphics Controller | NVIDIA® QUADRO® RTX 5000 GPU: 3072 CUDA cores Power: 265 Watts Cooling: Active |
| | Memory | 16GB HBM2 memory Memory Bandwidth: Up to 448 GB/s ECC Memory (disabled by default) |
| Connectors | DP (x4) with HDR support 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink for RTX 5000 connectors (via optional kit) After market option Kit: no power adapter included with card. | |

Technical Specifications - Graphics

| | |
|-----------------------------------|--|
| | DisplayPort™ to VGA, DisplayPort™ to DVI (single-link and dual-link), and DisplayPort™ to HDMI adapters available as accessories. |
| Maximum Resolution | DisplayPort™ 1.4: 7680x4320 @ 60Hz |
| Image Quality Features | HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort™ and HDMI connectors NVIDIA 3D Vision™ technology NVIDIA Mosaic and nView Desktop Management |
| Display Outputs | 4x DP1.4 HDR2 outputs (up to 7680x4320 @ 60Hz) |
| GPU Architecture | NVIDIA® Volta™ |
| Supported Graphics APIs | DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| Available Graphics Drivers | Windows® 10 64-bit Windows® 8 & 8.1 64-bit Windows® 7 64-bit Linux® 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters included After market option kit: No adapters included |

*VirtualLink's USB-C™ (data) cannot be disabled at a hardware level

NVIDIA® Quadro® RTX 6000 24GB Graphics

| | |
|----------------------------|--|
| Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 995 grams + 75 grams extender |
| Graphics Controller | NVIDIA® QUADRO® RTX 6000 GPU: 4608 CUDA cores Power: 295 Watts Cooling: Active |
| Memory | 24GB HBM2 memory Memory Bandwidth: Up to 672 GB/s ECC Memory (disabled by default) |
| Connectors | DP (x4) with HDR support 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink for RTX 5000 connectors (via optional kit) |

Technical Specifications - Graphics

After market option Kit: no power adapter included with card.

DisplayPort™ to VGA, DisplayPort™ to DVI (single-link and dual-link), and DisplayPort™ to HDMI adapters available as accessories.

Maximum Resolution DisplayPort™ 1.4:
7680x4320 @ 60Hz

Image Quality Features HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode)
HDCP 2.2 support over DisplayPort™ and HDMI connectors
NVIDIA 3D Vision™ technology
NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 HDR2 outputs (up to 7680x4320 @ 60Hz)

GPU Architecture NVIDIA® Volta™

Supported Graphics APIs DirectX®12, OpenGL® 4.5
Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran

Available Graphics Drivers Windows® 10 64-bit
Windows® 8 & 8.1 64-bit
Windows® 7 64-bit
Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters included

After market option kit: No adapters included

*VirtualLink's USB-C™ (data) cannot be disabled at a hardware level

Technical Specifications - Graphics

| | | |
|--|-----------------------------------|--|
| NVIDIA® RTX A5000 24GB Graphics | Form Factor | Full-Height Dual Slot (4.4"? Height x 10.5"? Length) Weight: 1049 grams + 80 grams extender |
| | Graphics Controller | NVIDIA® RTX A5000 GPU: 8192 CUDA Cores Power: 230W Cooling: Active |
| | Memory | 24GB GDDR6 Memory Bandwidth: Up to 768GB/s ECC Memory (disabled by default) |
| | Connectors | DP (x4) with HDR support One 8-pin auxiliary power connector After market option Kit: no power adapter included with card. |
| | Maximum Resolution | DisplayPort™ 1.4a: 7680x4320 @ 120Hz |
| | Display Outputs | 4x DP1.4a HDR2 outputs (up to 7680x4320 @ 120Hz) |
| | GPU Architecture | NVIDIA® Ampere™ |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters included
After market option kit: No adapters included

Technical Specifications - Graphics

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|--|-----------------------------------|---|
| NVIDIA® RTX™ A6000 48GB Graphics | Form Factor | Full-Height Dual Slot (4.4"? Height x 10.5"? Length) Weight: 1230 grams / 2.71 lbs (with extender) |
| | Graphics Controller | NVIDIA® RTX™ A6000 Graphics GPU: 10752 NVIDIA® CUDA® Parallel Processing Cores Power: 300 Watts Cooling: Active |
| | Memory | 48GB GDDR6 memory ECC optional Memory Bandwidth: Up to 768 GB/s Memory Width: 384 bit |
| | Connectors | 4x DP 1.4a Quadro Sync II connector Ampere NVLink® Stereo Sync Requires 8-pin CPU auxiliary power |
| | Maximum Resolution | 5120x2880 @ 60Hz (up to 4 displays) |
| | Display Outputs | 4x DP 1.4 (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX® 12, OpenGL® 4.6, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran™ |
| | Available Graphics Drivers | Windows® 10 64-bit Linux® 64-bit |
| <p>HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html</p> | | |

| | | |
|---|----------------------------|--|
| NVIDIA® Quadro® RTX 8000 48GB Graphics | Form Factor | Full-Height Dual Slot (4.4"? Height x 10.5"? Length) Weight: 1070 grams / 2.35 lbs |
| | Graphics Controller | NVIDIA® Quadro® RTX 8000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active |
| | Memory | 48GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit |
| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adaptors available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |

Technical Specifications - Graphics

| | |
|------------------------------------|---|
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView |
| Display Outputs¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| Available Graphics Drivers | Windows® 10 64-bit Linux® 64-bit |
| Notes | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays 2- VirtualLink's USB-C™ (data) cannot be disabled at a hardware level |

| | |
|---|---|
| Radeon™ Pro WX 7100 8GB Graphics | Form Factor Full-Height Single Slot (9.5" Length) |
| | Graphics Controller Radeon™ Pro WX 7100 graphics GPU: 2304 Stream Processors organized into 36 Compute Units Power: 130 Watts Cooling: Active |
| | Memory 8GB GDDR5 memory Memory Bandwidth: 7 Gbps / 224 GB/s Memory Width: 256 bit |
| | Connectors 4x Display Port 1.4 - HDR ready connectors with HBR3 and MST support. Factory Configured: No video cable adapter included After market option kit: No video cable adapter included Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution 5K support @ 60Hz <ul style="list-style-type: none"> 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| | Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | GPU Architecture GCN 4th Generation |
| | Supported Graphics APIs DirectX®12 OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0 |
| | Available Graphics Drivers Windows 10 Windows® 7 64-bit Linux® 64-bit |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| Notes | 12. HDR content requires that the system be configured with a fully HDR ready content chain, including: graphics card, monitor/TV, graphics |

Technical Specifications - Graphics

- driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
13. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
 14. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
 15. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Radeon™ Pro WX 9100 16GB Form Factor Graphics

Dual Slot (4.4" Height x 10.5" Length)

Graphics Controller

Radeon™ Pro WX 9100 graphics
GPU: 4096 Stream Processors
Power: 250 Watts
Cooling: Active

Memory

16GB HBM2 memory
Memory Bandwidth: Up to 483 GB/s
Memory Width: 2048 bit

Connectors

6x Mini DisplayPort 1.4 - HDR ready connectors with HBR3 and MST support.

Factory Configured: No video cable adapter included
After market option kit: No video cable adapter included

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution

8K support @ 60Hz
Single monitor, single or dual-cable

Image Quality Features

Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling

Display Output

6 full physical mDP 1.4 HDR Ready outputs
FreeSync support

GPU Architecture

Vega™

Supported Graphics APIs

DirectX® 12.1
OpenGL® 4.5
OpenCL™ 2.0
Vulkan™ 1.0

Available Graphics Drivers

Windows 10
Windows 7 available from AMD

Technical Specifications - Graphics

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site <http://welcome.hp.com/country/us/en/support.html>

Notes

1. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
2. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
3. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to current GPU load conditions.
4. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included
After market option kit: Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables
- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

| | | |
|--------------------------------|--------------------------------------|--|
| NVIDIA® Quadro® Sync II | Part number | 1WT20AA |
| | Dimensions (HxD) | 6.0 inches × 4.2 inches |
| | Devices Supported | NVIDIA® Quadro® P4000 NVIDIA® Quadro® P5000 NVIDIA® Quadro® P6000 |
| | Bus Type | Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector |
| | PCI Form Factor | Full Height, half length, single slot |
| | Ports | 2 RJ45 connectors for carrying frame lock signals over CAT5 cables. BNC Connector for external house synchronization. |
| | Internal Connectors | 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs <ul style="list-style-type: none"> • Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's • Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's |
| | System Requirements | Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards. Requires Quadro driver version R375 or later. |
| | Temperature - Operating | 0° to 55° C |
| | Temperature - Storage | -40° to 60° C |
| | Relative Humidity - Operating | 10% to 80% |
| | Power Requirements | Board power dissipation: <15W |
| | Operating Systems Supported | Windows 10 Windows 7 64-bit Linux® 64-bit |
| | Kit Contents | Contains: <ul style="list-style-type: none"> • Quadro Sync II Card • 4 x 12-Inch Short Sync Cables • 2 x 24-Inch Long Sync Cables (Two) • Quick Start Guide |

Technical Specifications – Optical and Removable Storage

Optical and Removable Storage

| | | | |
|---------------------------------|--|---|--|
| HP 9.5mm Slim DVD Writer | Description | 9.5mm height, tray-load | |
| | Mounting Orientation | Either horizontal or vertical | |
| | Interface Type | SATA/ATAPI | |
| | Dimensions (WxHxD) | 128 x 9.5 x 127mm | |
| | Supported Media Types | DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| | Disc Capacity | DVD-ROM Full Stroke DVD Full Stroke CD | 8.5 GB DL or 4.7 GB standard < 200 ms (seek) < 200 ms (seek) |
| | Maximum Data Transfer Rates | CD ROM Read DVD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X |
| | Power | Source DC Power Requirements DC Current | SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p 5 VDC -< 800 mA typical, <1600 mA maximum |
| | Operating Environmental (all conditions non-condensing) | Temperature Relative Humidity Maximum Wet Bulb Temperature | 41° to 122° F (5° to 50° C) 10% to 80% 84° F (29° C) |
| | Kit Contents | HP SATA DVD Writer drive, installation guide. | |

Technical Specifications – Optical and Removable Storage

| | | | | |
|------------------------------------|---|-------------------------------|--|--|
| HP 9.5mm Slim DVD-ROM Drive | Description | 9.5mm height, tray-load | | |
| | Mounting Orientation | Either horizontal or vertical | | |
| | Interface Type | SATA / ATAPI | | |
| | Dimensions (WxHxD) | 128 x 9.5 x 127mm | | |
| | Disc Capacity | DVD-ROM | Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB | |
| | Access Times | DVD-ROM Single Layer | < 110 ms (typical) | |
| | | CD-ROM Mode 1 | < 110 ms (typical) | |
| | | Full Stroke DVD | < 230 ms (typical) | |
| | | Full Stroke CD | < 220 ms (typical) | |
| | Power | Source | SATA DC power receptacle | |
| | | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p | |
| | | DC Current | 5 VDC - <800mA typical, < 1600 mA maximum | |
| | Operating Environmental (all conditions non-condensing) | Temperature | 41° to 122° F (5° to 50° C) | |
| Relative Humidity | | 10% to 80% | | |
| Maximum Wet Bulb Temperature | | 84° F (29° C) | | |
| Kit Contents | 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide | | | |

| | | | |
|--|------------------------------|---|--|
| HP HH DVD Writer (16X RW DVD-R) | Description | HP Half Height DVD Writer | |
| | Mounting Orientation | Either Horizontal or vertical | |
| | Interface Type | SATA | |
| | Dimensions (WxHxD) | 146x42x165mm | |
| | Supported Media Types | DVD+R | |
| | | DVD+RW | |
| | | DVD+R DL | |
| | | DVD-R DL | |
| | | DVD-R | |
| | | DVD-RW | |
| Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard | |
| | Full Stroke DVD | 145ms (seek) | |
| | Full Stroke CD | 120ms (seek) | |
| Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X | |
| | DVD ROM Read | DVD+RW Up to 13X | |
| | | DVD-RW Up to 13X | |
| | | DVD+R DL Up to 12X | |
| | | DVD-R DL Up to 12X | |
| | | DVD-ROM Up to 12X | |
| DVD-ROM DL Up to 12X | | | |
| DVD+R Up to 16X | | | |
| DVD-R Up to 16X | | | |

Technical Specifications – Optical and Removable Storage

| | | |
|--|---|--|
| Power | Source | SATA DC power receptacle |
| | DC Power Requirements | 5 VDC ± 5% -100 mV ripple p-p 12 VDC ± 10% -200 mV ripple p-p |
| | DC Current | 5 VDC <1500mA typical, <2000 mA maximum. |
| Operating Environmental (all conditions non-condensing) | Temperature | 41° to 122° F (5° to 50° C) |
| | Relative Humidity | 10% to 90% (Non-Condensing) |
| Operating Systems Supported | Windows 10, Windows 7 Professional 64-bit. Red Hat Enterprise Linux WS4**,5, Desktop/Workstation. | |
| Kit Contents | No driver is required for this device, Native support is provided by operating system. HP SATA DVD Writer drive, Installation guide. | |

HP 9.5mm Slim BDXL Blu-Ray Writer

| | | |
|------------------------------------|--|---|
| Description | 9.5mm height, tray-load | |
| Mounting Orientation | Either horizontal or vertical | |
| Interface Type | SATA/ATAPI | |
| Dimensions (WxHxD) | 128 x 9.5 x 127mm | |
| Supported Media Types | BD-ROM BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | Blu-ray | 25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL) |
| | Full Stroke DVD | < 230 ms (seek) |
| | Full Stroke CD | < 220 ms (seek) |
| | Blu-ray | < 230 ms (seek) (Full Stroke Blu-ray) |
| | Startup Time | (Time to drive ready from tray loading) |
| | | BD-ROM (SL/DL) 25S / 28S |
| | | BD-R (SL/DL) 25S / 28S |
| | | BD-RE (SL/DL) 25S / 28S |
| | | DVD-ROM (SL/DL) 18S / 18S |
| | DVD-R (SL/DL) 25S / 25S | |
| | DVD-RW 25S | |
| | DVD+R (SL/DL) 25S / 25S | |
| | DVD+RW 25S | |
| | CD-ROM 15S | |
| Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X |
| | DVD ROM Read | DVD+RW Up to 8X |

Technical Specifications – Optical and Removable Storage

| | | |
|---|---|--|
| | | DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X |
| | Blu-ray | BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X |
| Power | Source | SATA DC power receptacle |
| | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p |
| | DC Current | 5 VDC -900 mA typical, 2000mA maximum |
| Operating Environmental (all conditions non- condensing) | Temperature | 41° to 122° F (5° to 50° C) |
| | Relative Humidity | 10% to 80% |
| | Maximum Wet Bulb Temperature | 84° F (29° C) |
| Kit Contents | 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide | |
| | As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation. | |

HP SD Card Reader

| | |
|------------------------------|--|
| Description | Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports SD 4-bit parallel transfer mode |
| Interface Type | USB 3.1 G1 High-speed interface |
| Dimensions (WxHxD) | 1.15 x .9 x .15 in (29.00 x 23.6 x 3.15 mm) Fits conveniently in the Front IO Bay |
| Supported Media Types | Secure Digital Card (SD) Secure Digital High Capacity (SDHC) SD Extended Capacity Memory Card (SDXC) SD Ultra High Speed II(SD UHSII) |
| | These additional media types are supported with a card adapter. miniSD miniSD High Capacity Micro SD Memory Card (MicroSD) Micro SD High Capacity Memory Card (MicroSDHC) |
| Kit Contents | Test Parameters/Conditions - Power applied, unit operating on system ±5% SD card reader |
| Approvals | USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT |

Technical Specifications – Optical and Removable Storage

| | |
|---------------|---------------------|
| Weight | 0.35 lbs. (0.16 kg) |
|---------------|---------------------|

Technical Specifications - Controller Cards

Controller Cards

| | | |
|---|--------------------------------------|---|
| HP Thunderbolt-3 Dual Port2 PCIe 1-port I/O Card | Data Transfer Rate | Supports up to 40 Gb/s (40,000 Mb/s) |
| | Devices Supported | Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows devices |
| | Bus Type | PCIe Slot. Slot 4 only |
| | Ports | Two Thunderbolt™ 3 external USB type-C output connectors (Rear) Two full size DisplayPort input connectors (Rear) |
| | Internal Connectors | One 2x5-Pin header connector |
| | System Requirements | Genuine Windows 10 Professional, slot 4 PCH PCIe slot. |
| | Temperature - Operating | 50° to 131° F (10° to 55° C) |
| | Temperature - Storage | -22° to 140° F (-30° to 60° C) |
| | Relative Humidity - Operating | 20% to 80% |
| | Compliances | FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC |
| | Operating Systems Supported | Genuine Windows 10 Professional. |
| | Kit Contents | HP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO (General-Purpose Input/Output) cables, Installation documentation and warranty card. |

*Maximum speed requires DisplayPort™ and PCIe aggregation.

Networking and Communications

| | | |
|--|--|--|
| Integrated Intel I219 PCIe GbE Controller | Connector | RJ-45 |
| | Controller | Intel I219 GbE platform LAN connect networking controller |
| | Data Rates Supported | 10/100/1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED Indicators | <p>Link/Activity LED</p> <ul style="list-style-type: none"> • Off = No link • Blinking = Activity <p>Speed LED</p> <ul style="list-style-type: none"> • Off = 10Mbps • Amber = 100Mbps • Green = 1000Mbps |
| Management Capabilities | <p>Wake-On-LAN, Intel® Active Management Technology™ (AMT) 11.1x</p> <p>NOTE: Intel® AMT™ is not available on Intel Core X configs.</p> | |

| | | |
|--|-------------------------------------|--|
| Integrated Intel I210 (not available on Intel Core X configs) | Connector | RJ-45 |
| | Controller | Intel® I210 |
| | Data Rates Supported | 10/100/1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED Indicators | <p>Link/Activity LED</p> <ul style="list-style-type: none"> • Off = No link • Blinking = Activity <p>Speed LED</p> <ul style="list-style-type: none"> • Off = 10Mbps • Amber = 100Mbps • Green = 1000Mbps |
| Management Capabilities | <p>Wake-On-LAN</p> | |

Technical Specifications - Networking and Communications

| | | |
|-----------------------|---|---|
| Intel® I210-T1 | Networking Interface | RJ-45 |
| | System Interface | PCI Express 2.1 x1 |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 0.81W |
| | Physical Dimensions | Length: 6.7cm (2.64 inches) (Bracket) Width: 1.8cm (0.709 inches) Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches) |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

| | | |
|-----------------------|---|--|
| Intel® I350-T2 | Networking Interface | 2 x RJ-45 |
| | System Interface | PCI Express 2.1 x4 |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 4.4W |
| | Physical Dimensions | Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED |

Technical Specifications - Networking and Communications

- Off = 10Mbps
- Green = 100Mbps
- Amber = 1Gbps

Operating Temperature 0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B,
EU: UL CE,
Japan: VCCI,
Taiwan: BSMI,
Australia/New Zealand: CTICK,
Korea: KCC,
Canada: ICES-003/NMB-003

Intel® I350-T4

Networking Interface 4 x RJ-45

System Interface PCI Express 2.1 x4

Networking Speeds Supported 10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m) Cat3 (or higher) for 10Mbps
Cat5 (or higher) for 100Mbps
Cat5e (or higher) for 1Gbps

Power Consumption (active-typical) 5W

Physical Dimensions Length: 13.54cm (5.33 inches)
Width: 6.89 (2.71 inches)
Full-height end bracket: 12.0cm (4.725 inches)
Low-profile end bracket: 7.92cm (3.117 inches)

Connect Speed LED Indicators Link/Activity LED

- Off = No link
 - Blinking = Activity
- Speed LED

- Off = 10Mbps
- Green = 100Mbps
- Amber = 1Gbps

Operating Temperature 0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B,
EU: UL CE,
Japan: VCCI,
Taiwan: BSMI,
Australia/New Zealand: CTICK,
Korea: KCC,
Canada: ICES-003/NMB-003

Technical Specifications - Networking and Communications

| | | |
|-----------------------|---|--|
| Intel® X550-T2 | Networking Interface | 2 x RJ-45 |
| | System Interface | PCI Express 3 x4 |
| | Networking Speeds Supported | 100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps |
| | Cabling (up to 100m) | Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6a (or higher) for 10Gbps |
| | Power Consumption (active-typical) | 3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps |
| | Physical Dimensions | 5.2 in x 2.7 in (without bracket) |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = No link • Amber = <10Gbps • Green = 10Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

| | | |
|---|--|---|
| Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC | Network Interface | 1Gb LC Fiber 850 nm |
| | System Interface | PCIeG2 x1, Half Height, Half Length |
| | Networking Speeds Supported | 1000Base-X (1Gbps) |
| | Cabling | 50/125 µm (core/cladding) multimode fiber optic cable up to 500m 62.5/125 µm (core/cladding) multimode fiber optic cable up to 220m |
| | Power Consumption (active- typical) | 1.5 Watts |
| | Physical Dimensions | 8.8 cm x 6.9 cm (3.5 in x 2.7 in) |
| | Connect Speed LED Indicators | ON: 1Gbps Link OFF: Link down |
| | Operating Temperature | -25°C to 70°C (-13°F to 158°F) |
| | Hardware Certifications | IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation) RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI |

Technical Specifications - Networking and Communications

| | | |
|---|---|---|
| Intel® X710-DA2 10GBASE-SR Converged Network Adapter | Networking Interface | 2 SFP+ Ports for LC SFP+ Transceivers |
| | System Interface | PCI Express 3.0 x8 |
| | Networking Speeds Supported | 1Gbps, 10Gbps |
| | Cabling | LC fiber optic cabling with LC SFP+ Transceivers |
| | Power Consumption (active-typical) | 4.3W |
| | Physical Dimensions | 6.578 in x 2.703 in |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

Note: Windows 7 is NOT supported

| | | |
|--------------------------------------|------------------------------|---|
| 10GbE SFP+ SR Transceiver | Connector Type | LC |
| | Cable Type | 62.5/125um or 50/125um (core/cladding), graded-index, low metal content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC 793-2 Type A1b or A1a, respectively. |
| | Cable Length | 2-300m |
| | Wavelength | 850nm |
| | Form Factor | SFP+ |
| | Physical Dimensions | 0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm) |
| | Operating Temperature | 0C to 45C (32F to 113F) |
| | Operating Humidity | 0% to 85%, noncondensing |

Technical Specifications - Networking and Communications

| | | |
|-------------------------|---------------------------|---|
| Intel® 8265 WLAN | Networking Speeds | 802.11ac MU-MIMO (up to 867 Mbps) Bluetooth 4.2 |
| | IEEE WLAN Standard | IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending |
| | Bluetooth | 4.2 |
| | System Interface | PCI Express 2.1 x1 |
| | Antenna | 2x2 |

Summary of Changes

Summary of Changes

| Date of change: | Version History: | | Description of change: |
|--------------------|------------------|---------|--|
| November 1, 2017 | From v1 to v2 | Added | HP DisplayPort to HDMI Adapter, NVIDIA SLI 2-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section |
| | | Changed | Graphics, Storage / Hard Drives and Memory sections, changed Front and internal view info on the Overview section, changed Operating Systems section, changed System Board section, changed System Configuration, DECLARED NOISE EMISSIONS and Physical Security and Serviceability sections |
| November 29, 2017 | From v2 to v3 | Added | Processors, hard drives and graphics to offerings, added Intel Xeon W-2195 to Processors section |
| | | Changed | Wattage links on power supply section updated and Voltage links on efficiency section updated |
| February 5, 2018 | From v3 to v4 | Added | Features and Supported Configurations for Intel® Core™ X- Series Processor Family |
| | | Changed | Formatting |
| February 27, 2018 | From v4 to v5 | Added | Intel Core i9-X processors footnotes added to processors pre-installed section |
| March 27, 2018 | From v5 to v6 | Added | NVIDIA Quadro GP100 16GB Graphics, NVIDIA Quadro GV100 32GB Graphics and AMD Radeon Pro WX 9100 16GB Graphics as High End 3D in Graphics section |
| August 13, 2018 | From v6 to v7 | Added | Footnote to Networking and Communications section |
| | | Changed | Operating Systems section |
| August 24, 2018 | From v7 to v8 | Changed | Format |
| September 21, 2018 | From v8 to v9 | Added | Intel Optane SSD 905p AiC 280GB & 480GB |
| September 26, 2018 | From v9 to v10 | Changed | NVIDIA Quadro P6000 Graphics specs |
| February 11, 2019 | From v10 to v11 | Added | NVIDIA Quadro RTX 5000 16GB and NVIDIA Quadro RTX 6000 24GB Graphics, added Intel Core i9-9980XE, Intel Core i9-9920X, Intel Core i9-9820X and Intel Core i7-9800X processors |
| | | Changed | Storage section and Format changes |
| May 8, 2019 | From v11 to v12 | Changed | Storage and Graphics sections |
| June 12, 2019 | From v12 to v13 | Changed | Storage section |
| June 24, 2019 | From v13 to v14 | Changed | RAID Support |
| July 15, 2019 | From v14 to v15 | Changed | Corrected Intel 905p Series AIC 480GB PCIe SSD |
| July 18, 2019 | From v15 to v16 | Changed | HP SD 4 Card Reader part number |
| July 23, 2019 | From v16 to v17 | Changed | Windows 10 Pro High End added to Processors and under Intel Core X-series Processors Preinstalled Power supply-high end section re-arranged |
| September 1, 2019 | From v17 to v18 | Added | Footnote to Memory section, Added HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section |
| October 26, 2019 | From v18 to v19 | Changed | Graphics section |
| November 1, 2019 | From v19 to v20 | Added | HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section |
| December 5, 2019 | From v20 to v21 | Added | Intel Xeon W-2200, Intel Core i9-10900X X-series processors and added new HP Z4 G4 Memory Cooling Solution on Other Hardware section |
| | | Changed | Storage / Hard Drives, Memory and System Board sections |
| January 2, 2020 | From v21 to v22 | Changed | Front I/O and Rear I/O Overview subsections and changed Storage section |
| February 6, 2020 | From v22 to v23 | Changed | Storage / Hard Drives, Optical and Removable Storage and Physical Security and Serviceability |
| June 5, 2020 | From v23 to v24 | Added | AMD Radeon Pro W5500 and AMD Radeon Pro W5700 to Graphics section |
| | | Changed | HARD DRIVE CONTROLLERS section |
| January 5, 2021 | From v24 to v25 | Changed | Processors, Memory, Graphics, Racking and Physical Security, Operating Systems and Hard Drives sections |
| January 7, 2021 | From v25 to v26 | Changed | Hard Drives section |
| February 1, 2021 | From v26 to v27 | Changed | NETWORKING AND COMMUNICATIONS section |
| March 1, 2021 | From v27 to v28 | Changed | Overview and Memory sections |
| April 13, 2021 | From v28 to v29 | Changed | Graphics, Social and Environmental Responsibility sections |
| April 21, 2021 | From v29 to v30 | Changed | Memory section |
| May 1, 2021 | From v30 to v31 | Changed | Graphics and Software sections |

Summary of Changes

| | | | |
|----------------|-----------------|---------|---------------------------------------|
| June 1, 2021 | From v31 to v32 | Changed | Memory section |
| July 1, 2021 | From v32 to v33 | Changed | Graphics section |
| July 16, 2021 | From v33 to v34 | Changed | Racking and Physical Security section |
| August 1, 2021 | From v34 to v35 | Changed | Graphics section |

title

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